

MELSEC QnA Series

Programmable Controller

User's Manual (Hardware)

Q2A(S1)/Q3A/Q4ACPU



■ SAFETY PRECAUTIONS

(Read these precautions before using.)

When using Mitsubishi equipment, thoroughly read this manual and the associated manuals introduced in this manual.

Also pay careful attention to safety and handle the module properly.

These ● SAFETY PRECAUTIONS ● classify the safety precautions into two categories: "DANGER" and "CAUTION".



Procedures which may lead to a dangerous condition and cause death or serious injury if not carried out properly.



Procedures which may lead to a dangerous condition and cause superficial to medium injury, or physical damage only, if not carried out properly.

Depending on circumstances, procedures indicated by **!** CAUTION may also be linked to serious results.

In any case, it is important to follow the directions for usage.

Store this manual in a safe place so that you can read it whenever necessary. Always forward it to the end user.

[DESIGN PRECAUTIONS]

!> DANGER

- Install a safety circuit external to the PC that keeps the entire system safe even when there are problems with the external power supply or the PC module. Otherwise, trouble could result from erroneous output or erroneous operation.
- (1) Outside the PC, construct mechanical damage preventing interlock circuits such as emergency stop, protective circuits, positioning upper and lower limits switches and interlocking forward /reverse operations.

! DANGER

- (2) When the PC detects the following problems, it will stop calculation and turn off all output.
 - The power supply module has over current protection equipment and over voltage protection equipment.
 - The PC CPUs self-diagnostic functions, such as the watchdog timer error, detect problems. In addition, all output will be turned on when there are problems that the PC CPU cannot detect, such as in the I/O controller. Build a fail safe circuit exterior to the PC that will make sure the equipment operates safely at such times. See Section 4.2 of this user's manual for example fail safe circuits.

See this user's manual for example fail safe circuits.

- (3) Output could be left on or off when there is trouble in the outputs module relay or transistor. So build an external monitoring circuit that will monitor any single outputs that could cause serious trouble.
- Provide external safety circuits such as fuses to prevent smoking or ignition that occurred if an overcurrent higher than the rating or caused by a load short circuit, etc. flows in the output module continuously for a long time.
- Build a circuit that turns on the external power supply when the PC main module power is turned on. If the external power supply is turned on first, it could result in erroneous output or erroneous operation.
- Refer to the manual of each data link for the action state of each station caused by a communication error of the data link.
 - There is a risk of accidents due to erroneous outputs or erroneous operation.

[DESIGN PRECAUTIONS]

! DANGER

 When connecting a peripheral device to the CPU module or a personal computer, etc. to the special function module to perform control (data change) for the operating PLC, configure an interlock circuit in the sequence program to ensure that the whole system will always operate safely.

When performing other control (program change, operating status change (status control)) for the operating PLC, read the manual carefully and ensure safety fully before starting the control. In the above control performed especially for a remote PLC from an external device, immediate response may not be made to PLC side faults due to a data communication error.

Configure an interlock circuit in the sequence program, and also determine between the external device and PLC CPU the corrective action, etc. to be taken as a system at occurrence of a data communication error.

! CAUTION

- Do not bunch the control wires or communication cables with the main circuit or power wires, or install them close to each other. They should be installed 100mm (3.94inch) or more from each other. Not doing so could result in noise that would cause erroneous operation.
- When controlling items like lamp load, heater or solenoid valve using an output module, large current (approximately ten times greater than that present in normal circumstances) may flow when the output is turned OFF→ON. Take measures such as replacing the module with one having sufficient rated current.

[INSTALLATION PRECAUTIONS]

<!> DANGER

- Use the PC in an environment that meets the general specifications contained in this manual. Using this PC in an environment outside the range of the general specifications could result in electric shock, fire, erroneous operation, and damage to or deterioration of the product.
- Install so that the pegs on the bottom of the module fit securely into the base unit peg holes. Not installing the module correctly could result in erroneous operation, damage, or pieces of the product falling. When installing more cables, be sure that the base unit and the module connectors are installed correctly. After installation, check them for looseness. Poor connections could cause an input or output failure.
- Correctly connect the extension cable securely to the connector of the module mounted on the base unit. After installing, check. A poor contact could cause an input or output failure.
- Correctly connect the memory card installation connector to the memory card. After installation, be sure that the connection is not loose. A poor connection could cause an operation failure.
- Always mount or dismount the module after switching off all phases of the external power supply. Not doing so may damage the product.
- Do not directly touch the module's conductive parts or electronic components. Touching the conductive parts could cause an operation failure or give damage to the module.

[WIRING PRECAUTIONS]

<!> DANGER

- Completely turn off the external power supply when installing or placing wiring. Not completely turning off all power could result in electric shock or damage to the product.
- When turning on the power supply or operating the module after installation or wiring work, be sure that the module's terminal covers are correctly attached. Not attaching the terminal cover could result in electric shock.

! CAUTION

- Be sure to ground the FG terminals and LG terminals to the protective ground conductor. Not doing so could result in electric shock or erroneous operation.
- When wiring in the PC, be sure that it is done correctly by checking the product's rated voltage and the terminal layout. Connecting a power supply that is different from the rating or incorrectly wiring the product could result in fire or damage.
- Do not connect multiple power supply modules in parallel. Doing so could cause overheating, fire or damage to the power supply module. If the terminal screws are too tight, it may cause falling, short circuit or erroneous operation due to damage of the screws or module.
- Crimp or pressure weld the external connection connector with a tool designated by the manufacturer or solder it correctly.
 Improper connection could cause a short circuit, fire or erroneous operation.
- Tighten the terminal screws with the specified torque. If the terminal screws are loose, it could result in short circuits, fire, or erroneous operation.
 - Tightening the terminal screws too far may cause damage to the screws and/or the module, resulting in fallout, short circuits, or malfunction.
- Be sure there are no foreign substances such as sawdust or wiring debris inside the module. Such debris could cause fires, damage, or erroneous operation.
- External connections shall be crimped or pressure welded with the specified tools, or correctly soldered. For information regarding the crimping and pressure welding tools, see the I/O module's user's manual. Imperfect connections could result in short circuit, fires, or erroneous operation.

[STARTUP AND MAINTENANCE PRECAUTIONS]

DANGER

- Do not touch the terminals while power is on. Doing so could cause shock or erroneous operation.
- Correctly connect the battery. Also, do not charge, disassemble, heat, place in fire, short circuit, or solder the battery. Mishandling of battery can cause overheating or cracks which could result in injury and fires.
- Switch all phases of the external power supply off when cleaning the module or tightening the terminal screws. Not doing so could result in electric shock.

! CAUTION

- The online operations conducted for the CPU module being operated, connecting the peripheral device (especially, when changing data or operation status), shall be conducted after the manual has been carefully read and a sufficient check of safety has been conducted. Operation mistakes could cause damage or problems with the module. Do not disassemble or modify the modules. Doing so could cause trouble, erroneous operation, injury, or fire.
- Switch all phases of the external power supply off before mounting or removing the module. If you do not switch all phases of the external power supply, it will cause failure or malfunction of the module.
- When using a radio communication device such as a cellular phone or Personal Handy Phone system (PHS), use it at least 25cm away from the PLC.
 - Not doing so can cause a malfunction.
- Always make sure to touch the grounded metal to discharge the electricity charged in the body, etc., before touching the module.
 Failure to do so may cause a failure or malfunctions of the module.
- Do not drop the battery fitted to the module, and do not give it impact.
 Doing so may damage the battery, causing battery fluid to leak inside the battery. Do not use the battery that has been dropped or given impact, but dispose of it.
- Before touching the module, be sure to touch a grounded metal or the like to discharge static charge accumulated on your body.
 If static charge is not discharged, failure or malfunction of the module will be caused.

[DISPOSAL PRECAUTIONS]

! CAUTION

When disposing of this product, treat it as industrial waste.

REVISIONS

*The manual number is given on the bottom right of the front cover.

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Jun., 1996	IB(NA) 66607-A	First edition
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		Addition
		Specifications, Performance specifications, EMC standards, Low-Voltage instruction
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		5.1.1, 5.2.1
		Partial corrections
		Safety precautions, 1.1, 3.1.3, 3.1.4, 3.2.2,
D 0000	ID(NA) CCCCZ D	4.2, 4.3.3, 4.5.1, 4.5.2, Chapter 6
Dec., 2003	IB(NA) 66607-D	Partial corrections
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Japanese Manual Version F

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This manual describes the operating precautions, input/output connections, and error codes related to Q2ACPU, Q2ACPU-S1, Q3ACPU, and Q4ACPU (hereafter, all are referred to simply as "QnACPU") operations.

About Manuals:

Other manuals related to QnACPU operation (shown below) are also available if necessary.

Detailed manuals

Manual Name	Manual No.
Q2A(S1)/Q3A/Q4ACPU User's Manual Discusses QnACPU performance, functions, and operation, and contains the specifications for the power supply, memory card, and base unit. (sold separately)	IB-66608
Q2A(S1)/Q3A/Q4ACPU, Q2AS(H)CPU(S1) User's Manual Corresponding Additional Explanation The functions and the instructions added for the version B functions of QnACPU and Q2AS(H) CPU are explained. (sold separately)	IB-66821

Related manuals

Manual Name	Manual No.
QnACPU Guidebook This manual is designed for first-time users of the QnACPU. It explains the procedures for all operations from program creation, to program writing to the CPU, and program debugging. It also explains how to use the QnACPU special features. (sold separately)	IB-66606
QnACPU Programming Manual (Fundamentals)	
This manual explains the programming procedures required for program creation. It also explains the device names, parameters, and program types. (sold separately)	IB-66614
QCPU(Q mode)/QnACPU Programming Manual (Common Instructions) This manual explains how to use the sequence instructions, basic instructions, and application instructions. (sold separately)	SH-080039
QnACPU Programming Manual (Special Function Module) This manual explains the dedicated instructions used with special function modules at the Q2ACPU(S1), Q3ACPU, and Q4ACPU. (sold separately)	IB-66616
QnACPU Programming Manual (AD57 Instructions) This manual explains the dedicated instructions used to operate the AD57(S1) CRT controller module at the Q2ACPU(S1), Q3ACPU, and Q4ACPU. (sold separately)	IB-66617
QCPU(Q mode)/QnACPU Programming Manual (PID Control Instructions) This manual explains the dedicated instructions used to execute PID control at the Q2ACPU(S1), Q3ACPU, and Q4ACPU. (sold separately)	SH-080040

Manual Name	Manual No.
QCPU(Q mode)/QnACPU Programming module (SFC) This manual explains the SW0IVD-SAP3 system configuration, performance specifications, functions, programming, debugging, and error codes. (sold separately)	SH-080041
Building-Block Type Input/Output Module User's Manual This manual gives the specifications for building- block type I/O modules. (sold separately)	IB-66140

1. SPECIFICATIONS

1.1 SPECIFICATIONS

Table 1.1 General specification

Item		Specifications				
Ambient operating temperature	0 to 50 °C					
Ambient storage temperature			–20 to 7	75 °C		
Ambient operating humidity		10	to 90 % RH, N	No-condensing		
Ambient storage humidity		10	to 90 % RH, N	No-condensing		
			Frequency	Acceleration	Amplitude	No. of sweeps
Vibration	Conforming to JIS B 3502, IEC 61131-2	Under intermittent	10 to 57Hz		0.075mm (0.003in.)	10 times
resistance		vibration	57 to 150Hz	9.8m/s ²		each in X, Y, Z
	120 01131-2	Under continuous	10 to 57Hz		00.35mm (0.001in.)	directions
		vibration	57 to 150Hz	4.9m/s ²		(for 80min.)
Shock resistance	Conforming to JIS B 3502, IEC 61131-2 (147 m/s ² , 3 times in each of 3 directions X Y Z)					
Operating ambience		No corrosive gases				
Operating elevation *3	2000m (6562ft.) max.					
Installation location	Control panel					
Over voltage category *1	II max.					
Pollution level *2			2 ma	ax.		

- *1: This indicates the section of the power supply to which the equipment is assumed to be connected between the public electrical power distribution network and the machinery within premises. Category II applies to equipment for which electrical power is supplied from fixed facilities. The surge voltage withstand level for up to the rated voltage of 300 V is 2500 V.
- *2: This index indicates the degree to which conductive material is generated in terms of the environment in which the equipment is used. Pollution level 2 is when only non-conductive pollution occurs. A temporary conductivity caused by condensing must be expected occasionally.
- *3: Do not use or store the PC in the environment when the pressure is higher than the atmospheric pressure at sea level. Otherwise, malfunction may result. To use the PC in high-pressure environment, contact your nearest Mitsubishi representative.

2. PERFORMANCE SPECIFICATIONS

2.1 QnACPU Module Performance Specifications

This section gives the Performance specifications of the QnACPU.

Table 2.1 Performance Specifications

ltom			Model	Name		D	
	ltem		Q2ACPU	Q2ACPU-S1	Q3ACPU	Q4ACPU	Remark
Control system		Repeat	ed operation (ι	using stored p	rogram)		
I/O control method		Refresh mode				Direct input using device names possible	
D		_	Langu	age dedicated	to sequence	control	
Programmin	g languag	e	Relay sym	bol language, MELSAP		language,	
Processing s (sequence	speed	LD	0	.2	0.15	0.075	
instruction) (μs/step)		MOV	0	.6	0.45	0.225	
	Sequence instruction			3	9		
Number of	Basic Ins	structions					
instructions	Application						
Dedicated instructions							
Constant so		-	5 to 2000 (can be set in 5 ms units)				Set by parameter
Memory cap	acity		Capacity of the installed memory card (max. 2036 k bytes)				
Program	Number (steps)	of steps	Max. 28 k	Max. 60 k	Max. 92 k	Max. 124 k	
capacity	Number (files)	of files	28	60	92	124	
Number of I/O device points			8192 (X/Y	0 to 1FFF)		Number of points that can be used in programs	
Number of I/O points		512 (X/Y0 to 1FF)	1024 (X/Y0 to 3FF)	2048 (X/Y0 to 7FF)	4096 (X/Y0 to FFF)	Number of points actually accessible with I/O modules	

Table 2.1 Performance Specifications (Continued)

Item	Model Name				Remark
item	Q2ACPU	Q2ACPU-S1	Q3ACPU	Q4ACPU	Remark
Clock function	week (a		gnition of leap	o years) s)/d at 0 °C s)/d at 25°C	
Allowable momentary power interruption time	Depe	ends on the po	wer supply mo	odule	
Internal current consumption for 5 VDC (A)	0.3 (0.4)	0.3 (0.4)	0.3 (0.4)	0.6 (0.9)	The numerical value in parentheses represents a function version "B" or later unit.
Weight kg	0.8	0.8	0.8	0.8	
External dimensions mm (inch)	250(H) (9	9.84) × 79.5(W	() (3.13) × 121	(D) (4.76)	

REMARK

Please check the ratings label of the CPU unit for the function version "B".

<QnACPU>



3. EMC DIRECTIVE AND LOW-VOLTAGE INSTRUCTION

3.1 Requirements for Compliance to EMC Directive (89/336/EEC)

Compliance with the EMC directive, one of EU directives, is now compulsory. The EMC directive is a directive requiring measures against "electromagnetic emission" and for "electromagnetic immunity."

Sections 3.1.1 through 3.1.6 describe cautionary items of configuration of mechanical equipment with MELSEC-QnA Series PLCs to meet requirements of EMC directives.

Though we made our best efforts to prepare description based on the requirements of the regulations and standards we have obtained, we do not guarantee that the entire mechanical equipment manufactured according to the description herein complies with the above-mentioned directives. Final judgment of the method for complying with EMC directives and judgment of compliance are up to the manufacturer of the applicable mechanical equipment.

3.1.1 EMC standards

When the PLC is installed following the directions given in this manual its EMC performance is compliant to the following standards and levels as required by the EMC directive.

Specifications	Test Item	Test Description	Standard Values
EN50081-2: 1995 EN55011 Conduction poise		Measure the emission released by the product.	30M-230 M Hz QP : 30dBμ V/m (30m measurement) *1 230M-1000MHz QP : 37dBμ V/m (30m measurement)
	Measure the emission released by the product to the power line.	150k-500kHz QP : 79dB, Mean : 66dB*1 500k-30MHz QP : 73dB, Mean : 60dB	
	IEC801-2 Static electricity immunity *2	Immunity test by applying static electricity to the module enclosure.	4kV contact discharge 8kV air discharge
prEN50082-2: 1991	IEC801-3 Radiated electromagnetic field *2	Immunity test by applying aradiated electric field to the product.	10V/m, 27-500MHz
	IEC801-4 First transient burst noise	Immunity test by applying burst noise to the power line and signal cable.	2kV

Specifications	Test Item	Test Description	Standard Values
	EN61000-4-2 Static electricity immunity *2	Immunity test by applying static electricity to the module enclosure.	4kV contact discharge 8kV air discharge
	EN61000-4-4 First transient burst noise	Immunity test by applying burst noise to the power line and signal cable., 2kV	2kV
EN50082-2 : 1995	ENV50140 Radiated electromagnetic field AM modulation *2	Immunity test by applying aradiated electric field to the product.	10V/m, 80-1000MHz, 80% AM modulation@1kHz
ENV50204 Radiated electromagnetic field Pulse modulation *2	Immunity test by applying aradiated electric field to the product.	10 V/m, 900MHz, 80% AM modulation@1 k Hz	
	ENV50141 Conduction noise	Immunity test by inducting an electromagnetic field in the power line signal cable.	10 V/ms, 0.15-80MHZ, 80% AM modulation@1kHz

- (*1) QP: Quasi-peak value, Mean: Average value
- (*2) The PLC is an open type device (device installed to another device) and must be installed in a conductive control box.

The tests for the corresponding items were performed while the PLC was installed to inside the control box.

3.1.2 Installation inside the control cabinet

Since the PLC is an open type device (device incorporated into another device), it must be installed in the control cabinet. This has a good effect of not only for assuring safety but also for shielding noise emitted from the PLC, by means of the control cabinet.

(1) Control cabinet

- (a) Use a conductive control cabinet.
- (b) When attaching the control cabinet's top plate or base plate, mask painting and weld so that good surface contact can be made between the cabinet and plate.
- (c) To ensure good electrical contact with the control cabinet, mask the paint on the installation bolts of the inner plate in the control cabinet so that contact between surfaces can be ensured over the widest possible area.

- (d) Earth the control cabinet with a thick wire so that a low impedance connection to ground can be ensured even at high frequencies.(22mm2 wire or thicker is recommended.)
- (e) Holes made in the control cabinet must be 10cm (3.94in.) diameter or less. If the holes are 10cm (3.94in.) or larger, radio frequency noise may be emitted.
- (2) Connection of power and ground wires Earthing and power supply wires for the PLC system must be connected as described below.
 - (a) Provide an earthing point near the power supply module. Earth the power supply's LG and FG terminals (LG: Line Ground, FG: Frame Ground) with the thickest and shortest wire possible. (The wire length must be 30cm (11.18in.) or shorter.) The LG and FG terminals function is to pass the noise generated in the PC system to the ground, so an impedance that is as low as possible must be ensured. As the wires are used to relieve the noise, the wire itself carries a large noise content and thus short wiring means that the wire is prevented from acting as an antenna.
- Note) A long conductor will become a more efficient antenna at high frequency.
 - (b) The earth wire led from the earthing point must be twisted with the power supply wires. By twisting with the earthing wire, noise flowing from the power supply wires can be relieved to the earthing. However, if a filter is installed on the power supply wires, the wires and the earthing wire may not need to be twisted.

3.1.3 Cables

The cables led from the control cabinet contain a high frequency noise element and outside the control panel these cables act as antennae and radiate noise. The cables connected to input/output modules or special modules which leave the control panel must always be shielded cables.

Mounting of a ferrite core on the cables is not required (excluding some models) but if a ferrite core is mounted, the noise radiated through the cable can be suppressed further.

Use of a shielded cable is also effective for increasing the noise immunity level. The PLC system's input/output and special function module provide a noise immunity level of equivalent to that stated in IEC801-4: 2 k V when a shielded cable is used. If a shielded cable is not used or if the shield earthing treatment is not suitable even when used (See Section 3.1.6), the noise immunity level is less than 2 kV.

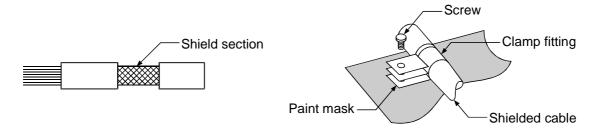
Note) prEN50082-2 specifies the noise resistance level based on the signal wire application.

Signals involved in process control: 2kV Signals not involved in process control: 1kV

The meaning of "involved in process control" is not defined in prEN50082-2. However, when the purposes of the EMC Directive are considered, the signals that could cause personal injury or risks in the facility if a malfunction occurs should be defined as "signals involved in process control". Thus, it is assumed that a high noise immunity level is required.

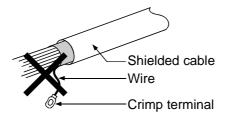
(1) Shield earthing

When a shield of the shielded cable is earthed to the cabinet body, please ensure that the shield contact with the body is over a large surface area. If the cabinet body is painted it will be necessary to remove paint from the contact area. All fastenings must be metallic and the shield and earthing contact must be made over the largest available surface area. If the contact surfaces are too uneven for optimal contact to be made either use washers to correct for surface inconsistencies or use an abrasive to level the surfaces. The following diagrams show examples of how to provide good surface contact of shield earthing by use of a cable clamp.



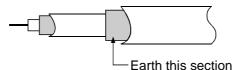
- (a) Peal the cable insulation off and expose the shield section
- (b) Sandwich the exposed shield section with the and earth to the control cabinet over a wide area.

Note) The method of earthing by soldering a wire onto the shield section of the shielded cable as shown below is not recommended. The high frequency impedance will increase and the shield will be ineffective.



- (2) MELSECNET/II module, MELSECNET/10 module
 - (a) The following requirements apply to AJ71QAR21, AJ71QLR21, AJ71QBR11.

Always use a triaxial cable for the module. The radiated noise in the band of 30 M Hz or higher can be suppressed by using a triax cable. Earth the outer shield by the method described in (1).

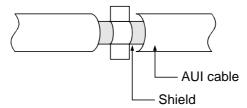


(b) Always mount a ferrite core onto the triaxial cable. Mount the ferrite core near the control cabinet outlet of each cable. Use of the TDK ZCAT3035 ferrite core is recommended.

(3) Ethernet module

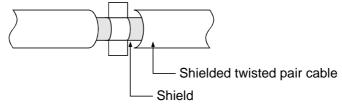
Precautions for the AUI cable, twisted pair cable and coaxial cable are described below.

(a) Be sure to ground the AUI cable connected to the 10-BASE-5 connector. AUI is a shielded cable. Strip of a part of the sheath as shown in the figure below, and ground the exposed shield in as wide an area as possible.



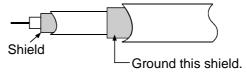
For the shield grounding treatment, refer to (1).

(b) Use a shielded twisted pair cable for the twisted pair cable connected to the 10-BASE-T connector. Strip of a part of the sheath of the shielded twisted pair cable as shown in the figure below, and ground the exposed shield in as wide an area as possible.



For the shield grounding treatment, refer to (1).

(c) Be sure to use double shielded coaxial cable for the coaxial cable connected to the 10-BASE-2 connector. Ground the outer shield to ground the double shielded coaxial cable.



For the shield grounding treatment, refer to (1).

Ethernet is a registered trademark of XEROX Co., Ltd. in the U.S.

(4) I/O and other communication cables
Always earth the shield section of the I/O signal cables and other
communication cables (RS-232-C, RS-422, etc.) in the same manner
as described in (1) if the cables go outside of the control cabinet.

(5) Positioning Modules

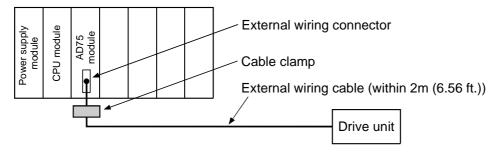
(a) When wiring with a 2m (6.6ft.) or less cable

Ground the shield section of the external wiring cable with the cable clamp.

(Ground the shield at the closest location to the AD75 external wiring connector.)

Wire the external wiring cable to the drive unit and external device with the shortest distance.

Install the drive unit in the same panel.



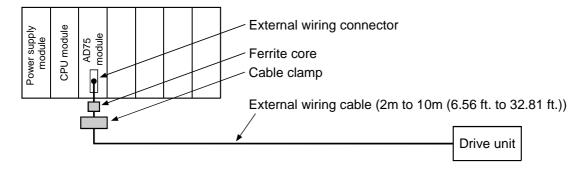
(b) When wiring with cable that exceeds 2m (6.6ft.), but is 10m (32.8ft.) or less

Ground the shield section of the external wiring cable with the cable clamp.

(Ground the shield at the closest location to the AD75 external wiring connector.)

Install a ferrite core.

Wire the external wiring cable to the drive unit and external device with the shortest distance.



(c) Ferrite core and cable clamp types and required quantities

1) Cable clamp

Type: AD75CK (Mitsubishi Electric)

2) Ferrite core

Type: ZCAT3035-1330 (TDK ferrite core)

3) Required quantity

Cable lenght	Propared part	Required Qty			
Cable length	Prepared part	1 axis	2 axis	2 axis	
Within 2m (6.6ft.)	AD75CK	1	1	1	
2m (6 6ft) to 10m	AD75CK	1	1	1	
2m (6.6ft.) to 10m (32.8ft.)	ZCAT3035-133 0	1	2	3	

3.1.4 Power supply module

The precautions required for each power supply module are described below. Always observe the items noted as precautions.

Model	Precautions
A61P, A62P	Not used
A63P	Use the 24VDC panel power equipment conforming to the EU Directive.
A61PEU, A62PEU	Always ground the LG and FG terminals after short-circuiting them.

3.1.5 Ferrite core

The ferrite core effectively reduces radiation noise in a band between 30 and 100MHz. Though the ferrite core is not compulsory except for some models, installation of the ferrite core is recommended if the shielding effect of the cable routed outside the panel is insufficient. The ferrite core used for our tests is ZCAT3035 made by TDK.

Install the ferrite core on the cable at a point just inside the panel that is routed outside the panel. An improper installation position will eliminate the effect of the ferrite core.

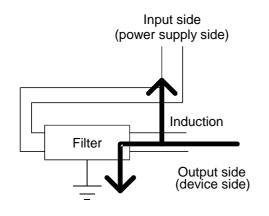
3.1.6 Noise filter (power supply line filter)

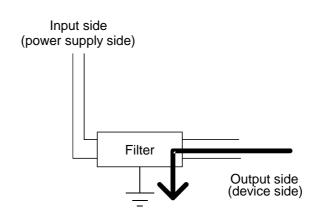
The noise filter (power supply line filter) is a device effective to reduce conducted noise. Except some particular models described in Section 3.1.3 (5), installation of a noise filter onto the power supply lines is not necessary. However conducted noise can be reduced if it is installed. (The noise filter is generally effective for reducing conducted noise in the band of 10 M Hz or less.) Usage of the following filters is recommended.

Model name	FN343-3/01	FN660-6/06	ZHC2203-11	
Manufacturer	SCHAFFNER	SCHAFFNER	TDK	
Rated current	3A	6A	3A	
Rated voltage	250V			

The precautions required when installing a noise filter are described below.

(1) Do not bundle the wires on the input side and output side of the noise filter. When bundled, the output side noise will be induced into the input side wires from which the noise was filtered.





- (a) The noise will be included when the input and output wires are bundled.
- (b) Separate and lay the input and output wires.
- (2) Earth the noise filter earthing terminal to the control cabinet with the shortest wire possible (approx. 10cm (3.94in.)).

3.2 Requirement to Conform to the Low-Voltage Instruction

The low-voltage instruction, one of the European Instructions, is now regulated. The low-voltage instruction require each device which operates with power supply ranging from 50 V AC to 1000 V and 75 V DC to 1500 V to satisfy necessary safety items.

In the Sections from 3.2.1 to 3.2.7, cautions on installation and wiring of the MELSEC-QnA series PC to conform to The Low Voltage Directive requires are described.

We have put the maximum effort to develop this material based on the requirements and standards of the regulation that we have collected. However, compatibility of the devices which are fabricated according to the contents of this manual to the above regulation is not guaranteed. Each manufacturer who fabricates such device should make the final judgement about the application method of the low-voltage instruction and the product compatibility.

3.2.1 Standard applied for MELSEC-QnA

The standard applied for MELSEC-QnA is EN61010-1 safety of devices used in measurement rooms, control rooms, or laboratories.

For the modules which operate with the rated voltage of 50VAC/75VDC or above, we have developed new models that conform to the above standard.

For the modules which operate with the rated voltage under 50VAC/75VDC, the conventional models can be used, because they are out of the Low Voltage Directive application range.

3.2.2 Precautions when using the QnA series

Module selection

(1) Power module

For a power module with rated input voltage of 100/200VAC, select a model in which the internal part between the first order and second order is intensively insulated, because it generates hazardous voltage (voltage of 42.4V or more at the peak) area.

For a power module with 24VDC rated input, a conventional model can be used.

(2) I/O module

For I/O module with rated input voltage of 100/200VAC, select a model in which the internal area between the first order and second order is intensively insulated, because it has hazardous voltage area.

For I/O module with 24VDC rated input, a conventional model can be used.

(3) CPU module, memory cassette, base unit Conventional models can be used for these modules, because they only have a 5VDC circuit inside.

(4) Special module

Conventional models can be used for the special modules including analog module, network module, and positioning module, because the rated voltage is 24VDC or less.

(5) Display deviceUse an A900 series GOT CE compatible model.

3.2.3 Power supply

The insulation specification of the power module was designed assuming installation category II. Be sure to use the installation category II power supply to the PC.

The installation category indicates the durability level against surge voltage generated by lighening strike. Category I has the lowest durability; category IV has the highest durability.

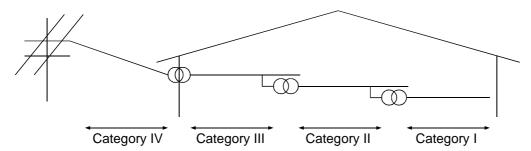


Figure 1.: Installation Category

Category II indicates a power supply whose voltage has been reduced by two or more levels of isolating transformers from the public power distribution.

3.2.4 Control box

Because the PLC is an open device (a device designed to be stored within another module), be sure to use it after storing in the control box.

- (1) Electrical shock prevention
 - In order to prevent persons who are not familiar with the electric facility such as the operators from electric shocks, the control box must have the following functions:
 - (a) The control box must be equipped with a lock so that only the personnel who has studied about the electric facility and have enough knowledge can open it.
 - (b) The control box must have a structure which automatically stops the power supply when the box is opened.
- (2) Dustproof and waterproof features

The control box also has the dustproof and waterproof functions. Insufficient dustproof and waterproof features lower the insulation withstand voltage, resulting in insulation destruction. The insulation in our PLC is designed to cope with the pollution level 2, so use in an environment with pollustion level 2 or below.

- Pollution level 1: An environment where the air is dry and conductive dust does not exist.
- Pollution level 2: An environment where conductive dust does not usually exist, but occasional temporary conductivity occurs due to the accumulated dust. Generally, this is the level for inside the control box equivalent to IP54 in a control room or on the floor of a typical factory.
- Pollution level 3: An environment where conductive dust exits and conductivity may be generated due to the accumulated dust.

An environment for a typical factory floor.

Pollution level 4: Continuous conductivity may occur due to rain, snow, etc. An outdoor environment.

As shown above, the PC can realize the pollution level 2 when stored in a control cabinet equivalent to IP54.

3.2.5 Module installation

(1) Installing modules contiguously

In A series PCs, the left side of each I/O module is left open. When installing an I/O module to the base, do not make any open slots between any two modules. If there is an open slot on the left side of a module with 100/200VAC rating, the printed board which contains the hazardous voltage circuit becomes bare. When it is unavoidable to leave an open slot, be sure to install the blank module (AG60).

When using the A5DB expansion base with no power supply, attach the cover packaged with the expansion base to the side of the leftmost module.

3.2.6 Grounding

There are two kinds of grounding terminals as shown below. Either grounding terminal must be used grounded.

Be sure to ground the protective grounding for the safety reasons.

Protective grounding \oplus : Maintains the safety of the PC and improves the noise

resistance.

Functional grounding \bigoplus : Improves the noise resistance.

3.2.7 External wiring

(1) 24VDC external power supply

For special modules that require a 24 V DC I/O module or external power supply, use a model whose 24 V DC circuit is intensively insulated from the hazardous voltage circuit.

(2) External devices

When a device with a hazardous voltage circuit is externally connected to the PLC, use a model whose circuit section of the interface to the PLC is intensively insulated from the hazardous voltage circuit.

(3) Insulation requirements
Voltages are shown in Table 2.

Table 2: Intensive Insulation Withstand Voltage (Installation Category II, source: IEC664)

Rated voltage of hazardous voltage area	Surge withstand voltage (1.2/50μs)		
150VAC or below	2500V		
300VAC or below	4000V		

4. LOADING AND INSTALLATION

4.1 Installing modules

4.1.1 Precautions for handling of modules

This section describes the precautions that must be taken when handling the CPU, I/O modules, special function modules, power supply module, base units, etc.

- (1) Module enclosure, memory cassette, terminal block connectors and pin connectors are made of resin; do not drop them or subject them to strong impact.
- (2) Do not remove modules' printed circuit boards from the plastic casing.
- (3) During wiring, take care to ensure that wiring off cuts, etc. do not get inside the case.If anything does get inside the case, remove it.
- (4) Tighten the module mounting (unnecessary in normal operating condition) and terminal block screws as indicated below.

Screw	Tightening Torque N · cm			
Module mounting screws (M4 screw) (optional)	78 to 118			
Terminal block screws	98 to 137			

(5) To install a module, push it firmly into the base unit so that the latch engages properly. To remove a module, press the latch to disengage it from the base unit, then pull the module out (for details, refer to the relevant PC CPU User's Manual).

4.1.2 Installation environment

The CPU system should not be installed under the following environmental conditions:

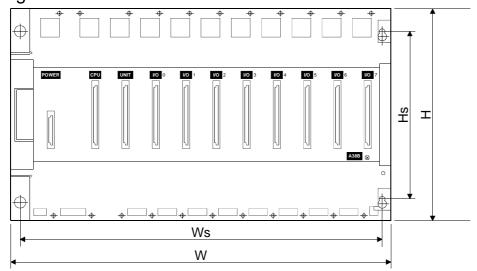
- (1) Places where ambient temperature is outside of 0 to 55°C range.
- (2) Places where ambient humidity is outside of 10 to 90%RH range.

- (3) Places where dewing (condensation) occurs due to sudden temperature changes.
- (4) Places where corrosive or inflammable gas exists.
- (5) Places where a large amount of dust, iron powder and other conductive powder, oil mist, salt or organic solvent exists.
- (6) places exposed to direct sunlight.
- (7) Places where a strong electric or magnetic field exists.
- (8) Places where mechanical vibrations or impacts are transmitted directly to the module body.

4.1.3 Precautions relating to the installation of the unit.

The following precautions must be observed when installing a PC to an operation panel or other bases considering fully the operability, maintainability, and resistance to the environment.

Mounting dimension
 Mounting dimensions of each base unit are as follows.

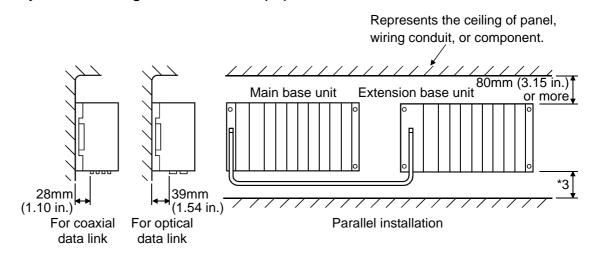


	A32B	A32B-S1	A35B	A38B A38HB	A62B	A65B	A68B	A52B	A55B	A58B
W	247	268	382	480	238	352	466	183	297	411
VV	(9.72)	(10.55)	(15.03)	(18.9)	(9.37)	(13.86)	(18.35)	(7.2)	(11.69)	(16.18)
Ws	227	248	362	460	218	332	446	163	277	391
	(8.93)	(9.76)	(14.25)	(18.11)	(8.58)	(13.07)	(17.6)	(6.42)	(10.9)	(15.4)
Н	250 (9.84)									
Hs	200 (7.87)									

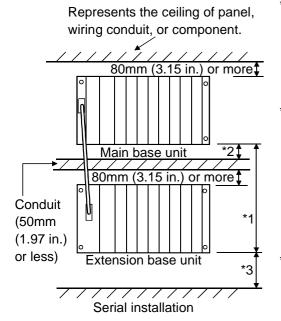
Dimensions: mm (inch)

(2) Unit mounting position

To ensure proper ventilation and make module replacement easy, provide a clearance of 80 mm (3.15 in.) or more between the top of the unit and any surrounding structure or equipment.



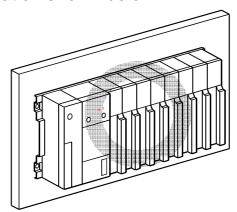
- (3) A wiring conduit should be provided if required.
 - If its clearance above or below the programmable controller is less than indicated in the figure above, observe the following points:
 - (a) If the wiring conduit is installed above the programmable controller, its height must be no greater than 50 mm (1.97 in.) to ensure good ventilation.
 - In addition, there should be adequate space between the programmable controller and the wiring conduit to allow module latches to be pressed.
 - It will not be possible to replace modules if their latches cannot be pressed.
 - (b) If the wiring conduit is installed below the programmable controller, it should be installed so as to allow connection of the optical fiber cable or coaxial cable, taking the minimum bending radius of the cable into consideration.



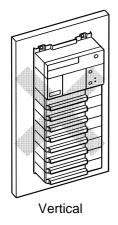
*1:	These dimensions vary depending on the length of the							
	extension cable as follows:							
	AC06B cable	.450mm (17.71 in.) or less						
	AC12B cable	.1050mm (41.34 in.) or less						
	AC30B cable	.2850mm (112.20 in.) or less						
*2:	When a link module is							
	not used	.50mm (1.97 in.) or more						
	When using $\phi 4.5 mm$							
	optical fiber cable,							
	or coaxial cable	.100mm (3.94 in.) or more						

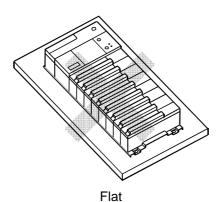
- (4) Unit mounting orientation
 - (a) Since the PC generates heat, mount it in a well-ventilated location and in the orientation shown below.

When using $\phi 8.5$ mm



(b) Do not mount it in either of the orientations shown below.

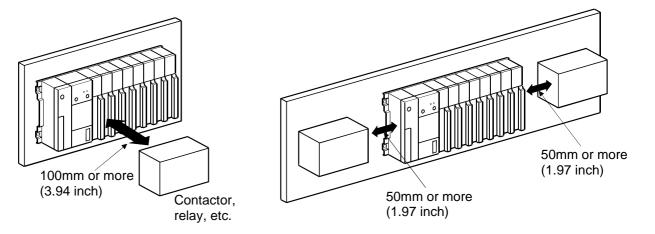




(5) Mount base unit on a flat surface.
If the mounting surface is uneven, this may strain the printed circuit boards and cause malfunctions.

- (6) Avoid mounting the base unit in proximity to vibration sources such as large magnetic contractors and no-fuse circuit breakers; mount these on a separate panel or at a distance.
- (7) In order to avoid the effects of radiated noise and heat, provide the clearances indicated below between the PC and devices that generate noise or heat (contactors and relays).

 - •Required clearance on the right and left of 50mm or more (1.97inch)



4.2 The view of a fail-safe circuit

When the programmable controller is switched ON/OFF, the outputs may temporarily be incorrect due to the delay time and difference between the start-up time of the programmable controller's power supply and that of the external power supply for process control (especially if it is DC).

For example, if the power to the PC is turned ON after tuning ON the external power supply used for the process control with the DC output module, the DC output module may make an erroneous output for an instant.

There is a possibility of abnormal operation if the external power supply is abnormal or a programmable controller fault occurs.

To prevent the abnormal operation of the whole system, machine breakdown, and accidents, build a fail-safe circuit (emergency stop, protective circuit, interlocking circuit, etc.) outside the PC.

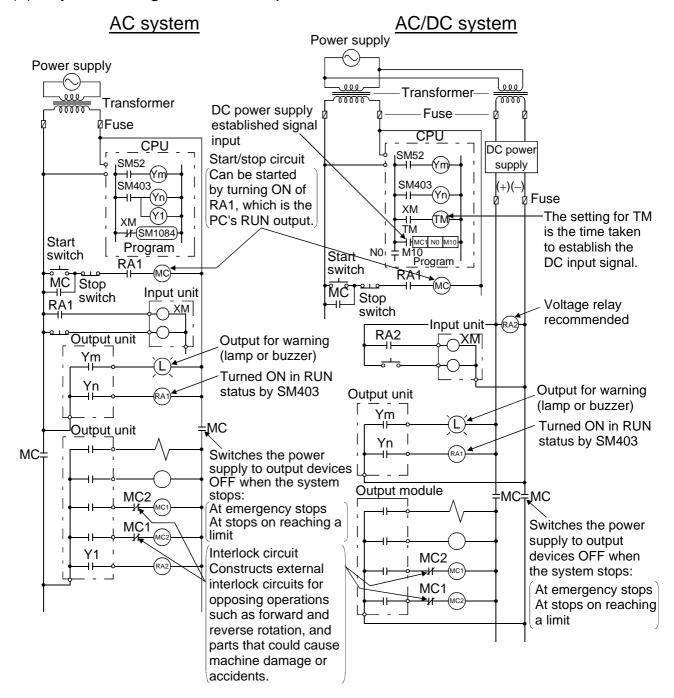
An example system design circuit is shown on the following page.

- !> DANGER Install a safety circuit external to the PC that keeps the entire system safe even when there are problems with the external power supply or the PC module. Otherwise, trouble could result from erroneous output or erroneous operation.
 - (1) Outside the PC, construct mechanical damage preventing interlock circuits such as emergency stop, protective circuits, positioning upper and lower limits switches and interlocking forward /reverse operations.
 - (2) When the PC detects the following problems, it will stop calculation and turn off all output.
 - The power supply module has over current protection equipment and over voltage protection equipment.
 - The PC CPUs self-diagnostic functions, such as the watchdog timer error, detect problems. In addition, all output will be turned on when there are problems that the PC CPU cannot detect, such as in the I/O controller. Build a fail safe circuit exterior to the PC that will make sure the equipment operates safely at such times. See Section 4.2 of this user's manual for example fail safe circuits.

See this user's manual for example fail safe circuits.

- (3) Output could be left on or off when there is trouble in the outputs module relay or transistor. So build an external monitoring circuit that will monitor any single outputs that could cause serious trouble.
- Build a circuit that turns on the external power supply when the PC main module power is turned on. If the external power supply is turned on first, it could result in erroneous output or erroneous operation.

(1) System design circuit example



The procedures used to switch on the power supply are indicated below.

AC system

- [1] Switch the power supply ON.
- [2] Set the CPU to RUN.
- [3] Switch the start switch ON.
- [4] The output devices are driven in accordance with program when the magnetic contactor (MC) comes ON.

AC/DC system

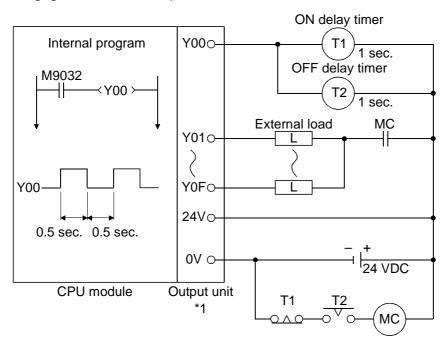
- [1] Switch the power supply ON.
- [2] Set the CPU to RUN.
- [3] Switch RA2 ON when the DC power supply starts.
- [4] Switch the timer (TM) ON when the DC power supply reaches working voltage. (The set value for TM must be the time it takes for 100% establishment of the DC power after RA2 is switched ON. Make this set value 0.5 seconds.)
- [5] Switch the start switch ON.
- [6] The output devices are driven in accordance with the program when the magnetic contactor (MC) comes ON. (If a voltage relay is used at RA2, no timer (TM) is necessary in the program.)

(2) Fail-safe measures to cover the possibility of PC failure
Problems with a CPU memory can be detected by the self diagnosis
function. However, problems with I/O control area may not be detected by
the CPU.

In such cases, all I/O points turn ON or OFF depending on a condition of problem, and normal operating conditions and operating safety cannot sometimes be maintained.

Though Mitsubishi PCs are manufactured under strict quality control, they may cause failure or abnormal operations due to unspecified reasons. To prevent abnormal operations of whole system, machine breakdown, and accidents, build a fail-safe circuit outside the PC.

The following gives an example of a fail-safe circuit



*1 Since Y00 alternates between ON and OFF at 0.5 second intervals, use a contactless output module (in the above example this is a transistor).

4.3 Power supply connection

4.3.1 Performance Specifications for Power Supply Modules

(1) Normal power supply module

Table 4.1 Power Supply Module Specifications

ltone		Specifications							
Item		A61P	A63P	A65P	A66P	A67P			
Base unit loading positi	on	Power supply module loading slot				I/O module loading slot	Power supply module loading slot		
		100-120 V	'AC +10% -15%	24VDC +30% -35%	100-120 \	110 VDC			
Input voltage			32 VAC)		(85 to132 VAC)		(85 to 140		
			AC +10 % -15 %	(15.6 to 31.2 VDC)	200-240 VAC +10 % -15 %		VDC)		
1 (6		`	264 VAC)		·	264 VAC)			
Input tretuen	-	50/60 F	lz ±5 %		50/60	Hz ±5 %			
Input voltage distortion fact			With	nin 5% (See Secti	on 4.4)	Γ	Γ		
Max. input apparent pov	ver	110 VA		65 W	110 VA	95 VA	65 W		
Inrush curren	ıt.	20	Α,	100 A,		20 A,			
	,		8 ms	within 1 ms	within 8 ms		3		
Rated output		8 A	5 A	8 A	2 A		8 A		
current	24 VDC	<u> </u>	0.8 A	<u> </u>	1.5 A	1.2 A			
*1	5 VDC	8.8 A	5.5 A	8.5 A	2.2 A		8.5 A		
Overcurrent		or higher	or higher	or higher	or higher	470	or higher		
protection	24 VDC	<u> </u>	1.2 A or higher	_	2.3 A or higher	1.7 A or higher	_		
*2	5 VDC	5.5	5.5	5.5	5.5		5.5		
Overvoltage		to 6.5 V	to 6.5 V	to 6.5 V	to 6.5 V		to 6.5 V		
protection	24 VDC								
Efficiency		65 % or higher							
Withstanding	voltage	1500 VAC for 1 minute between all AC external terminals together and ground 500 VAC for 1 minute between all DC external terminals together and ground							
Noise durability			e 1500 V.P.P.	· · · · · · · · · · · · · · · · · · ·		ltage 1500 P.P.	Noise voltage 500 V.P.P.		
Insulation res	Insulation resistance		10 M ^Ω or higher, measured with a 500 VDC insulation resistance tester						
Power indicator		Power LED display							
Terminal scre	ew size	M4 × 0.7 × 6				M3 × 0.5 × 6	M4 × 0.7 × 6		
				×Ό	×Ό				

Table 4.1 Power Supply Module Specifications

	Specifications									
Item		T	Specification	1	1	Т				
	A61P	A62P	A63P	A65P	A66P	A67P				
Applicable wire size			0.75 to 2 mm	2						
Applicable					V1.25-YS	V1.25-YS				
Applicable solderless terminal	V1.2	3A	4A,							
Soldeness terminal			V2-S3,	V2-S4,						
		V2-YS3A	V2-YS4A							
Applicable tightening torque: N · cm			69	118						
			250 (H) ×	250 (H) ×						
External dimensions rom			37.5 (W)×	55 (W)×						
External dimensions mm		121 (D)	121 (D)							
(inch)		(9.8× 1.5×	(9.8× 2.1×							
		4.7)	4.7)							
Weight kg	0.98	0.94	0.8	0.94	0.75	0.8				
Allowable momentary power interruption time *3	Less th	an 20ms	Less than 1ms	Less than 20ms		Less than 20ms (at 100 VDC)				

REMARK

The A66P module has the number of occupied slots shown below.1 slot

(2) Power supply module for CE marking

Table 4.2 Power Supply Module Specifications

		Specifications					
Item		A61PEU A62PEU					
Base unit loadin	g	Power supply module loading slot					
position		Fower supply me					
Input voltage		100-120 / 200-240 VAC +10% -15%					
input voltage		(85 to 26	64 VAC)				
Input frequency		50/60 H	z ±5 %				
Input voltage dis	stortion	Within 5% (Se	e Section 4.4)				
factor.		VVIII III 7 0 (88	5 556tierr 1: 1)				
Max. input appa	rent	130 VA	155 VA				
power Inrush current		20 A, wit	hin 9 mg				
Rated output	5 VDC	8 A	5 A				
current	24 VDC	_	0.8 A				
Overcurrent	5 VDC	8.8 A or higher	5.5 A or higher				
protection *1	24 VDC	_	1.2 A or higher				
Overvoltage	5 VDC	5.5 to 6.5 V	_				
protection *2	24 VDC	_	_				
Efficiency		65 % or higher					
		1500 VAC for 1 minute between all AC external terminals together and					
Withstanding vo	ltage	ground					
3 1	3	500 VAC for 1 minute between all DC external terminals together and					
Noise durability		ground Noise voltage IEC80	1-4: 2kV 1500 V n n				
•			• •				
Insulation resista	ance	10 MΩ or higher, measured with a 50					
Power indicator		Power LE	. ,				
Terminal screws Applicable wire s		$M4 \times 0.7 \times 6$ 0.75 to 2 mm^2					
Applicable wire s	SIZC	0.73 10	2 111111				
solderless termin	nal	V1.25-4,V1.25-YS4	A,V2-S4,V2-YS4A				
Applicable tightening		440 N	1				
torque		118 N	ı · cm				
External dimens	ions mm	250 (H) × 55 (W)× 121 (D) (9.8× 2.1× 4.7)					
(inch)							
Weight kg	nton.	0.8	0.9				
Allowable mome power interruption	•	Less than 20ms					
Power interruption	71 UITIG 3						

POINTS

*1: Overcurrent protection

- (a) The overcurrent protection device shuts off the 5VDC, 24VDC ladder and stops the system if the current flowing in the ladder exceeds the specified value.
 - When this device is activated, the power supply module LED is switched off or dimly lit.
- (b) If this happens, eliminate the cause of the overcurrent for example insufficient current capacity or short ladder then start up the system.
 - When the current has returned to normal, the system undergoes an initial start.

*2: Overvoltage protection

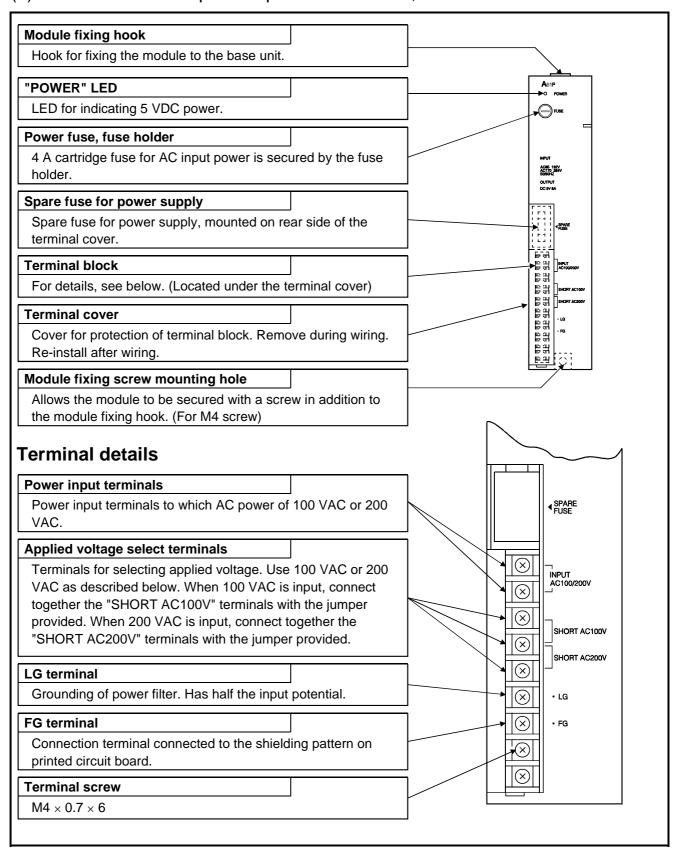
The overvoltage protection device shuts off the 5VDC ladder and stops the system if an excessive voltage in the range 5.5 to 6.5V is applied to this ladder.

- When this device is activated, the power supply module LED is switched off. If this happens, switch the input power OFF, then back ON to restart the system.
- If the system is not booted and the LED remains off, the power supply module must be changed.
- *3: Allowable momentary power interruption time
 The PC CPU allowable momentary power interruption time varies
 according to the type of power supply module.
 In the case of the A63P module, the allowable momentary power
 interruption time is defined as from when the 24VDC stabilized
 primary supply is cut off until the 24VDC voltage drops to the
 defined voltage (15.6VDC).

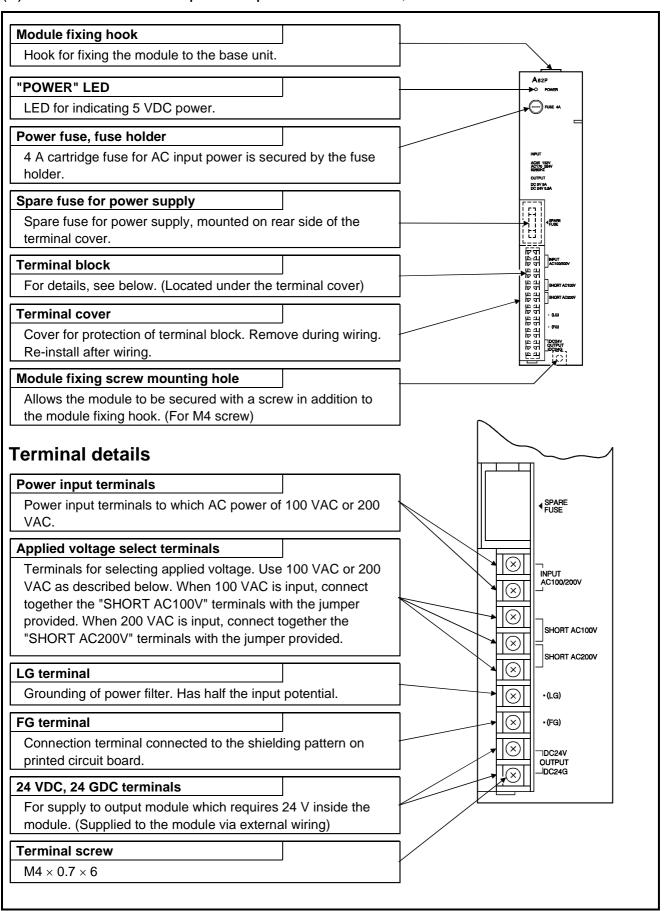
4.3.2 Part identification and setting of Power Supply Module

The names and descriptions of each of the parts of the power supply modules are given below.

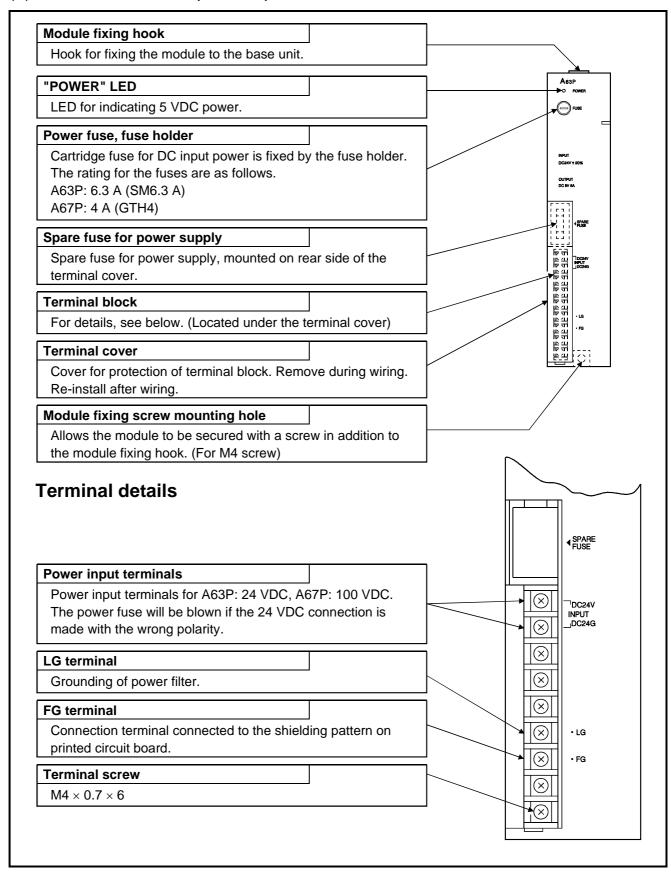
(1) Names and description of parts of the A61P, A61PEU module



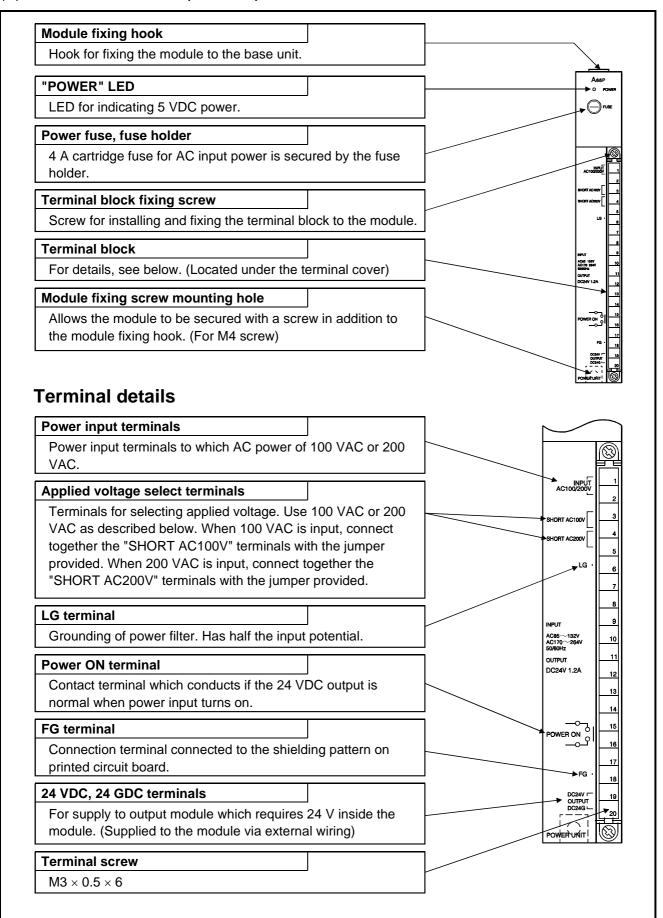
(2) Names and description of parts of the A62P, A62PEU and A65P modules



(3) Names and description of parts of the A63P and A67P modules

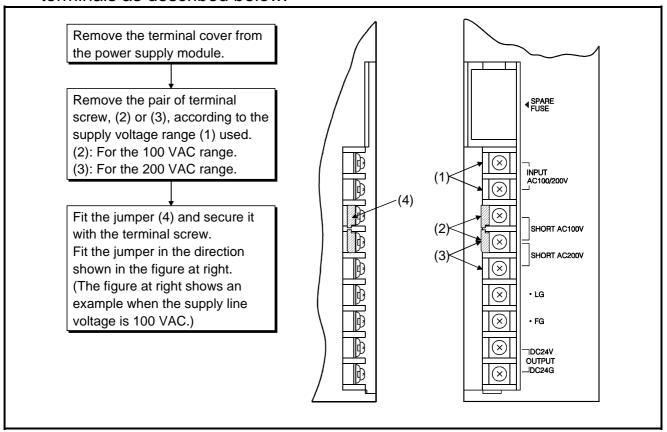


(4) Names and description of parts of the A66P module



(5) Setting

For A61P(EU), A62P(EU), A65P or A66P, the input voltage range, 100V or 200V, must be specified by placing a jumper (supplied) across two terminals as described below:



POINT

If the setting differs from the supply line voltage, the following occurs: do not mis-set.

	Supply Li	ne Voltage		
	100VAC	200VAC		
Setting to 100VAC (jumper fitted as indicated at (2))	_	The power supply module is damaged. (The CPU is not damaged.)		
Setting to 200VAC (jumper fitted as indicated at (3))	No error occurs in the module. However, the CPU does not operate.	_		
No setting (jumper not fitted)	No error occurs in the module. However, the CPU does not operate.			

4.3.3 Power Supply Connection

! DANGER

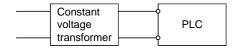
- Completely turn off the external power supply when installing or placing wiring. Not completely turning off all power could result in electric shock or damage to the product.
- When turning on the power supply or operating the module after installation or wiring work, be sure that the module's terminal covers are correctly attached. Not attaching the terminal cover could result in electric shock.

<u>/!\</u> CAUTION

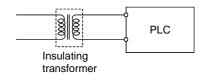
- When wiring in the PC, be sure that it is done correctly by checking the product's rated voltage and the terminal layout.
 Connecting a power supply that is different from the rating or incorrectly wiring the product could result in fire or damage.
- Tighten the terminal screws with the specified torque. If the terminal screws are loose, it could result in short circuits, fire, or erroneous operation.
 - Tightening the terminal screws too far may cause damage to the screws and/or the module, resulting in fallout, short circuits, or malfunction.
- Be sure there are no foreign substances such as sawdust or wiring debris inside the module. Such debris could cause fires, damage, or erroneous operation.
- External connections shall be crimped or pressure welded with the specified tools, or correctly soldered. For information regarding the crimping and pressure welding tools, see the I/O module's user's manual. Imperfect connections could result in short circuit, fires, or erroneous operation.

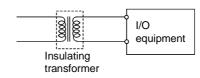
Instructions for wiring the power supply cable and I/O cable.

(1) When voltage fluctuations are larger than the specified value, connect a constant-voltage transformer.



(2) Use a power supply which generates minimal noise between wires and between the PLC and ground. If excessive noise is generated, connect an insulating transformer.



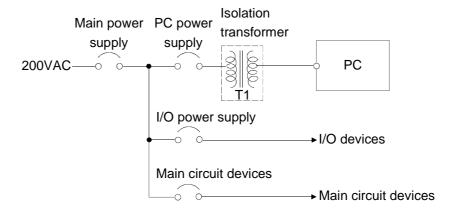


(3) When a power transformer or insulating transformer is employed to reduce the voltage from 200 VAC to 100 VAC, use one with a capacity greater than those indicated in the following table.

Power Supply Module	Transformer Capacity
A61P, A61PEU	110VA × n
A62P, A62PEU	110VA × n
A65P	110VA × n
A66P	95VA × n

n: Stands for the number of power supply modules.

(4) Provide separate wiring systems for the PC power, I/O devices, and operating devices as shown below.
If the wiring is influenced by excessive noise, connect an isolation



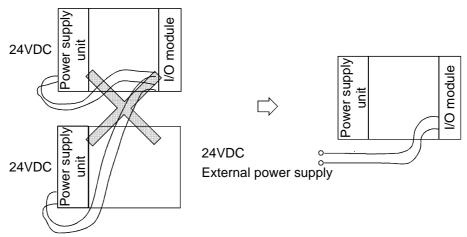
(5) Note on using the 24 VDC output of the A62P, A65P and A66P power supply module.



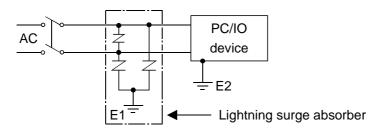
transformer.

Do not connect multiple power supply modules in parallel. Doing so could cause overheating, fire or damage to the power supply module. If the terminal screws are too tight, it may cause falling, short circuit or erroneous operation due to damage of the screws or module.

If the 24 VDC output capacity is insufficient for one power supply module, supply 24 VDC from the external 24 VDC power supply as shown below:



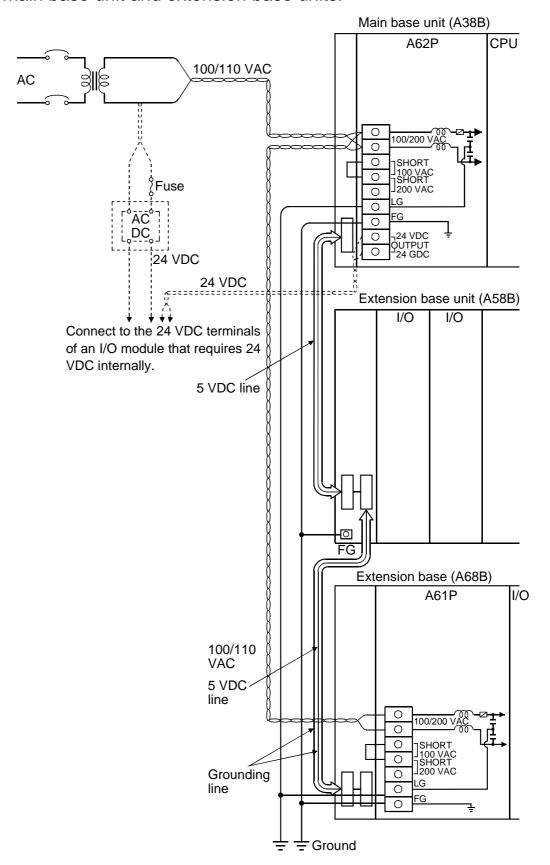
- (6) 100VAC, 200VAC, and 24VDC wires should be twisted as tightly as possible, and connect the modules at the shortest distance between them. To minimize voltage drop, use thick wires (MAX. 2mm²) where possible.
- (7) Do not bind 100VAC and 24VDC wires together with main circuit (high tension and large current) wires or I/O signal wires nor place them near each other. Provide 100mm (3.94 inch) clearance between the wires if possible.
- (8) As a measure against surges caused by lightning, insert a lightning surge absorber as shown below.



POINTS

- (1) Provide separate grounding for the lightning surge absorber (E1) and the PC (E2).
- (2) Select a lightning surge absorber whose maximum allowable circuit voltage is higher than the circuit voltage at the maximum power supply voltage.

(9) The following is an example of wiring of power supply and grounding wires to main base unit and extension base units.



POINTS

- (1) Use thick wires (MAX. 2mm2) where possible for the 100/200VAC and 24VDC power supply, and twist the wires from connected terminals. When a solderless terminal is used, use a solderless terminal with an insulation sleeve to prevent short-circuit if the terminal screw becomes loose.
- (2) When the LG and FG terminals are connected, they must be grounded. If LG terminals and FG terminals are connected without grounding the wires, the PLC may be susceptible to noise. Be aware not to touch the LG terminal since it has potential of half the input voltage.

4.4 Precaution when Connecting the Uninterruptive Power Supply (UPS)

Be sure of the following items when connecting the QnACPU system to the uninterruptive power supply (abbreviated as UPS hereafter):

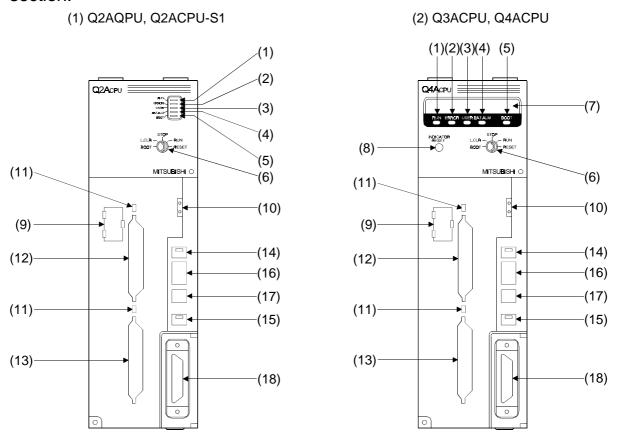
Use a UPS which employs the constant inverter power supply method with 5% or less voltage fluctuation.

Do not use a UPS with the constant commercial power supply method.

4.5 Nomenclature and Settings

4.5.1 Nomenclature and settings

The programmable controller nomenclature and settings are explained in this section.



Appearance with front cover open

No.	Name		Function
(1)	RUN LED	Lamp ON Lamp OFF	PU module operating Status. :When RUN/STOP key switch is set to RUN or STEP-RUN, and operation is in progress. :When RUN/STOP key switch is set to STOP, PAUSE or STEP-RUN and operation is stopped. Or, when an error that stops operation has been detected. :When a program is written during STOP and the RUN/STOP key switch is moved from "STOP" to "RUN". The CPU module is not in the RUN status. To put the CPU module in the RUN status, move the RUN/STOP key switch from "RUN" to "STOP" to "RUN" again. Alternatively, perform reset operation with the RUN/STOP key switch. (The Q3ACPU or Q4ACPU shows the "PRG. CHECK!!" message on the display.)
(2)	ERROR LED		:When a self-diagnosis error (excluding battery error) which does not stop operation has been detected. (When a "continue operation at error detection" parameter setting has been designated.) :Normal :When an error that stops operation has been detected.

No.	Name		Function			
(3)	USER LED	Lamp OFF	:An error has been detected by the CHK instruction, or an annunciator F has come ON. (With Q3ACPU or Q4ACPU, a message or the comment for the annunciator is displayed on the LED indicator.) :Normal :Flashing when latch clear is performed. (With Q3ACPU or Q4ACPU, the message "L. CLR RDY" is displayed on the LED indicator.)			
(4)	BAT.ALARM LED		:When a battery error is activated by a low voltage condition at the CPU module and memory card battery. :Normal			
(5)	BOOT LED	•	:When boot operation is completed. :When boot operation is not being executed.			
(6)	RUN/STOP key switch	L.CLR :	Sequence program operation EXECUTE/STOP. Sets all data in the latch area (designated by parameter) to "OFF" or "0". Also dears sampling trace and status latch registrations. Executes a hardware reset for operation error, and to initialize operation, etc.			
(7)	LED display (Q3A and Q4ACPU only)	16-character display Display content includes comments for self-diagnosis errors, comments for LED display instructions, clock data for SET SM212, and annunciator F-No. comments for SET F,etc.				
(8)	Display RESET switch (Q3A and Q4ACPU only)	Clears the LED display content, displays the next data (when next data exists).				
(9)	Battery (A6BAT)	Battery for intern	al memory and power failure backup.			
(10)	Battery connector pin	-	d wire connection. (To prevent wasted battery power e lead wire is disconnected from the connector when shipped)			
(11)	Memory card EJECT button	Ejects the memo	ory card from the CPU module.			
(12)	Memory card "A" installation connector Memory card "B" installation connector	Connectors for in	nstalling memory cards in the CPU module.			
(14)	Memory card "A" in/out (with built in LED)	inserted and ejec	ng determines whether or not the memory card can be cted while power is ON. Factory set to OFF.			
(15)	Memory card "B" in/out switch (with built in LED)		ejection prohibited (LED is ON) ejection permitted (LED is OFF)			

No.	Name		Function							
(16)	Ejects the memory card from the CPU ON 1 2 3 4 5	sw2 sw3 sw4 sw5	ON :Boot operation OFF :Boot operation is not performed. SW2 to SW4 : Parameter area. These switches designate the memory where parameters are stored. Internal Memory card A Memory card B RAM RAM ROM RAM ROM *SW2 to 4 are valid if SW1 is SW3 OFF OFF ON ON OFF ON OFF. SW4 OFF OFF OFF OFF ON							
(17)	System setting switch 2 ON 1 2	OFF : Designat factory so SW1: Fo SW2 : ON :	r future ex Periphera connected (Set to OI periphera immediate ACPU pe present QnACPU	pansion. It all protocol do to the Classical device. The lay upon seripheral device.	for CPU r Not used a . Designat PU moduler ACPU s The ON or witching.) evice 1: Fo	at present tes the typ e peripher station is to OFF setti or future e	es of peri ral interface be acce ng becon expansion	ssed from a		
(18)	RS-422 connector	 	or for conn	•		al devices).			

4.5.2 Switch settings and corresponding LED displays

(1) Program writing when CPU module is stopped.

To execute program writing when the CPU module is stopped, follow the key switch setting procedure shown below.

(a) RUN/STOP key switch :STOP RUN LED :OFF Q3ACPU, Q4ACPU display :OFF

...... CPU module STOP status → program write

(b) RUN/STOP key switch :RESET RUN LED :OFF

Q3ACPU, Q4ACPU display :"PRG.CHECK!" message is displayed

...... CPU module STOP status

(c) RUN/STOP key switch :STOP → RUN

RUN LED :ON Q3ACPU, Q4ACPU display :OFF

...... CPU module STOP status

POINT

- After writing a program (except for online program write), perform reset operation, and then place the CPU module in the RUN status.
- When remote STOP is switched to RUN, the CPU module is not put in the "PROG CHECK" status but is placed in the RUN status.
- (2) Latch CLEAR operation

To execute a "Latch CLEAR", follow the key switch setting procedure shown below.

- Turn the RUN/STOP key switch of the CPU module from the "STOP" position to the "L. CLR" position several times to flicker the "USER LED" on the CPU module front.
 - Normally, the LED flickers when the switch is turned several times (three or four times).
 - When the "USER LED" flickers, it indicates that latch clear is ready.
- 2) After the "USER LED" has flickered, turning the RUN/STOP key switch from the "STOP" position to the "L. CLR" position again executes latch clear and lights up the "USER LED". If the "USER LED" comes on for two seconds and then goes off, it indicates that latch clear is completed normally.
- 3) To cancel latch clear midway, turn the RUN/STOP key switch to the "RUN" position to place the CPU module in the RUN state, or turn it to the "RESET" position to make a reset.

POINTS

- The devices where the "Latch CLEAR" occurs can be designated by the "Latch CLEAR" enabled/disabled settings for each device made in device setting in the parameter mode.
- In addition to the RUN/STOP key switch method, a remote "Latch CLEAR" can also be executed from a GPP function peripheral device. (Refer to the Q2A (S1)/Q3A/Q4ACPU User's Manual).
- (3) Removing a memory card while PLC power is ON To remove the memory card while the PLC power is ON, set the "memory card in/out" switch as shown below. Removing a memory card while power is ON:

POINTS

- The built-in LED at the "memory card in/out" switch may not go OFF if a CPU module system function (sampling trace, status latch, etc.) is in progress, or if the memory card is being used by the program. In such cases, stop the system function or the program, then remove the memory card after checking that the switch's built-in LED has turned OFF.
- Do not turn the "memory card in/out" switch ON after removing the memory card. An error will occur if the switch is turned ON at this time.
- When there are parameter-set file registers, local devices or failure history, the memory card cannot be the removed.
 If the "memory card in/out" switch is turned OFF, the in/out switch built-in LED does not go off.
 - For the file registers, the memory card can be removed when they are set to be unused with the QDRSET(P) instruction.
- (4) Inserting a memory card while PLC power is ON To insert the memory card while the PLC power is ON, set the "memory card in/out" switch as shown below.
 - (a) Insert the memory card.
 - (b) Turn the "memory card in/out" switch ON (built-in LED ON)
 Memory card insertion/ejection prohibited

POINTS

- After inserting the memory card, turn the "memory card in/out" switch ON. The memory card cannot be used until the switch is turned ON.
- Since mount processing is performed again after the memory card is inserted, note that the scan time of one scan when mount processing is performed increases by a maximum of 10ms.

MEMO			

5. VO MODULE SPECIFICATIONS AND CONNECTIONS

This section presents the specifications and wiring drawings for each of the A series I/O modules.

5.1 Input Modules

5.1.1 Input module specifications

		Number	Detail		Operating	g Voltage	Maximum
Model	Input Type	of Points/M odule	Rated Input Voltage	Input Current	ON Voltage	OFF Voltage	Simultaneous ON Input Point (Percentage Simultaneous ON)
AX10		16 points		80VAC	40VAC	100%	
AX11 AX11EU		32 points	100VAC		or higher	or lower	60%
AX20	AC input	16 points		10mA	160VAC	70VAC	100%
AX21 AX21EU		32 points	- 200VAC		or higher	or lower	60%
AX40		16 points					100%
AX41 AX41-S1	DC input (sink type)	32 points	12/24 VDC	4/10mA	9.5VDC or higher	6VDC or lower	60%
AX42 *1		64 points	_	3/7mA			60% *3
AX50 AX50-S1	DC input (sink type) DC input (sink/source type)		48VDC	4mA	34VDC or higher	10VDC or lower	
AX60 AX60-S1	DC input (sink type) DC input (sink/source type)	16 points	100/110/ 125VDC	2mA	80VDC or higher	20VDC or lower	100%
			5VDC (SW ON)	3.5mA (TYP) 5.5mA (MAX)	3.5VDC or higher	1.1VDC or lower	
AX70 Sensor input (sink/source type)	16 points	12VDC (SW OFF)	2mA (TYP) 3mA (MAX)	5VDC	2VDC	100%	
			24VDC (SW OFF)	4.5mA (TYP) 6mA (MAX)	or higher	or lower	

	Input Response Time						
	OFF to ON	ON to OFF	External Connections	Common Terminal Arrangement	Internal Current Consumption	Number of Occupied I/O Points	
			20 terminal block connector	16 points/ common	0.055A	16 points	
	15msec or	25msec or	38 terminal block connector	32 points/ common	0.11A	32 points	
	less	less	20 terminal block connector	16 points/ common	0.055A	16 points	
			38 terminal block connector	32 points/ common	0.11A	32 points	
	10msec or less	10msec or less	20 terminal block connector	8 points/	0.055A	16 points	
			38 terminal block connector	common	0.11A	32 points	
			40-pin connector × 2	32 points/ common	0.12A	64 point	
			20 terminal	8 points/ common	0.055A	16 points	
	10msec or less	20msec or less	block connector				
	1.5msec or less	3msec or less	20 terminal block connector	8 points/ common	0.055A	16 points	
					(-	To nevt nage)	

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		Number	Rated		Operating	g Voltage	Maximum	
Model	Input Type	of Points/M odule	Input Voltage	Input Current	ON Voltage	OFF Voltage	Simultaneous ON Input Point (Percentage Simultaneous ON)	
			5VDC (SW ON)	3.5mA (TYP) 5.5mA (MAX)	3.5VDC or higher	1.1VDC or lower		
AX71	Sensor input (sink/source type)	32 points	12VDC (SW OFF)	2mA (TYP) 3mA (MAX)	5VDC	2VDC		
			24VDC (SW OFF)	4.5mA (TYP) 6mA (MAX)	or higher	or lower	100%	
AX80								
AX80E	DC input (source type)	16 points	12/24 VDC	4/10mA	9.5VDC or higher	6VDC or lower		
AX81	1		-					
AX81-S1	DC input	ce type) 32 points	12/24 VDC	2.5/5m	5.6VDC	2.4VDC	60%	
AX81-S2	DC input		48/60 VDC	3/4mA	or higher 31VDC or higher	or lower 10VDC or lower		
AX81-S3	(source type)		24VDC	4/10mA	9.5VDC or higher	6VDC or lower		
					At normal			
					21VDC	6VDC or lower		
AX81B	DC input (sink/source type)	32 points	24VDC	7mA	or higher When discondetected	1	60%	
	,				1VDC or higher	6VDC or lower		
AX82 *1	DC Input (source type)	64 points	12/24 VDC	3/7mA	9.5VDC or higher	6VDC or lower	60%	
AX31	AC/DC input	32 points	12/24 VAC 12/24 VDC	8.5/4m A	7VAC/ VDC or higher	2.5VAC/ VDC or lower	100%	
AX31-S1	DC input (sink/source type)	32 points	24VAC	8.5mA	16VDC or higher	8VDC or lower		

Input Response Time					
OFF to ON	ON to OFF	External Connections	Common Terminal Arrangement	Internal Current Consumption	Number of Occupied I/O Points
1.5msec or less	3msec or less	38 terminal block connector		0.11A	32 points
10msec or less [TV 5.5msec [High-spe 0.5msec or less	6.0msec	20 terminal block connector	8points/ common		16 points
10msec or less	10msec or less	38 terminal block connector			32 points
less	less			0.11A	
10msec or less	10msec or less	38 terminal block connector	8 points/ common	0.125A	64 points
10msec or less	10msec or less	37-pin D subconnector × 2		0.12A	64 points
25msec or less 20msec or less 10msec or	20msec or less	38 terminal block connector	32 points/ common	0.11A	32 points
less	less				

The following specifications apply to all modules: Isolation method : Photocoupler

Input indication : LEDs

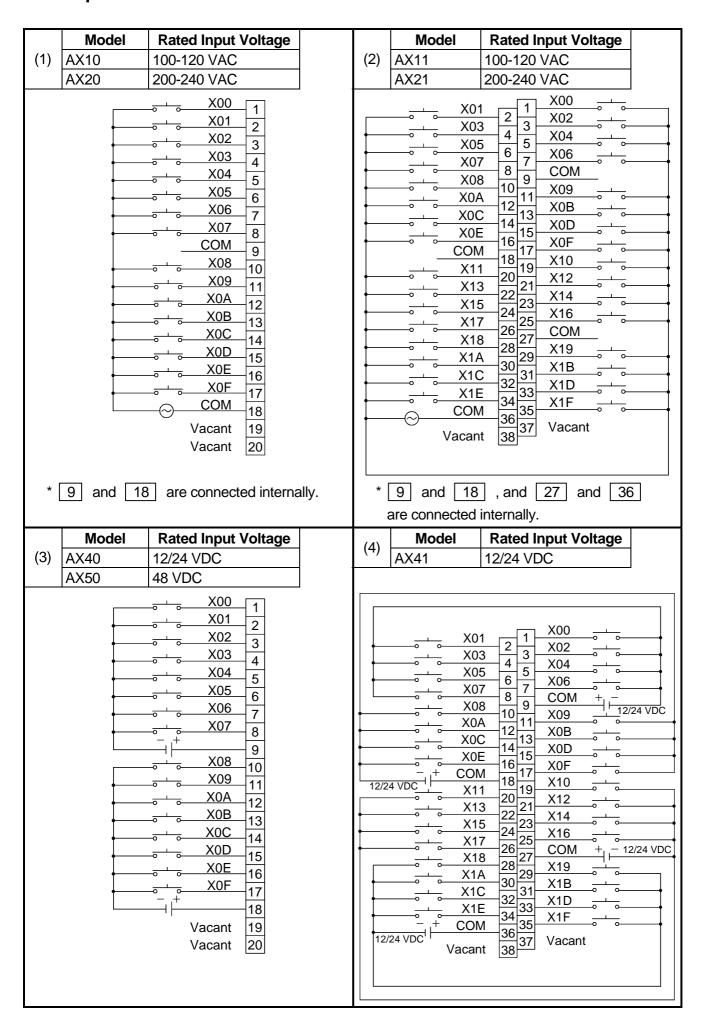
*1: The ON/OFF status of the first or latter half is indicated by the LEDs in accordance with the setting of the selector switch on the front panel of the module:

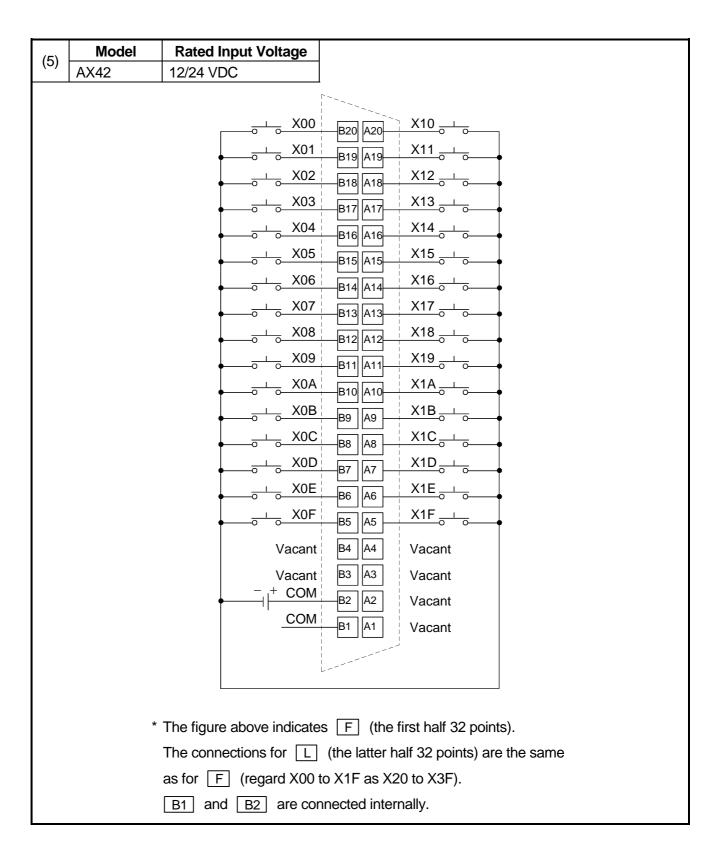
FH setting: First half (X00 to X1F), LH setting: Latter half (X20 to X3F)

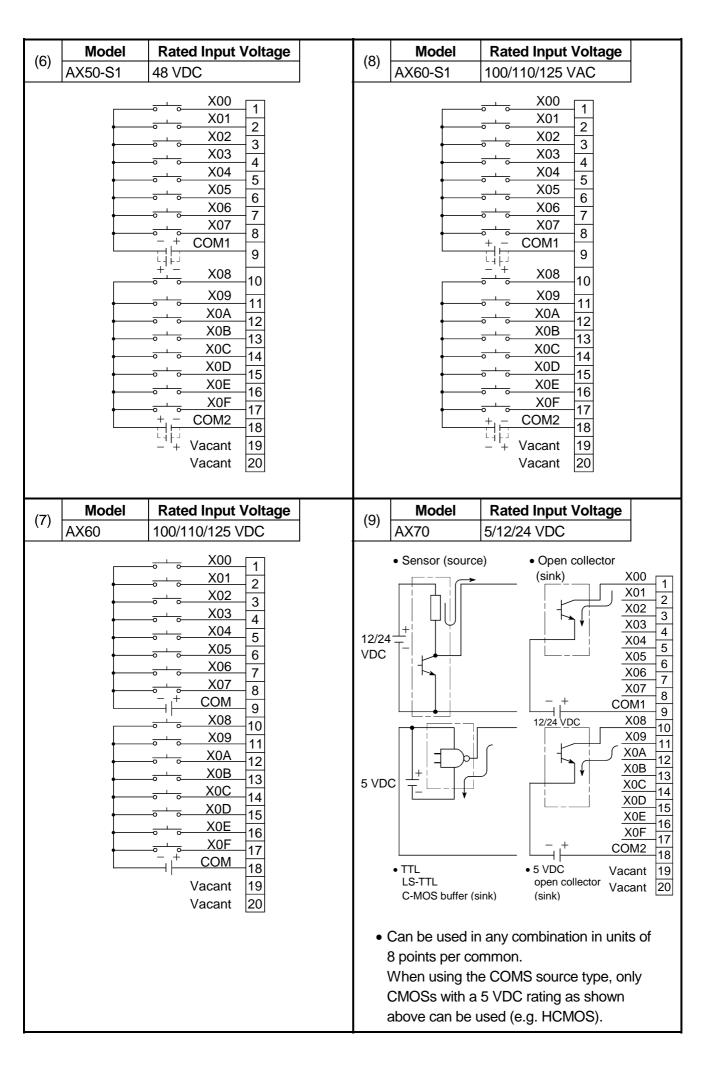
*2: It is possible to select high speed or low speed for the upper eight points only using the DIP switch: HIGH setting: high-speed, LOW setting: low-speed

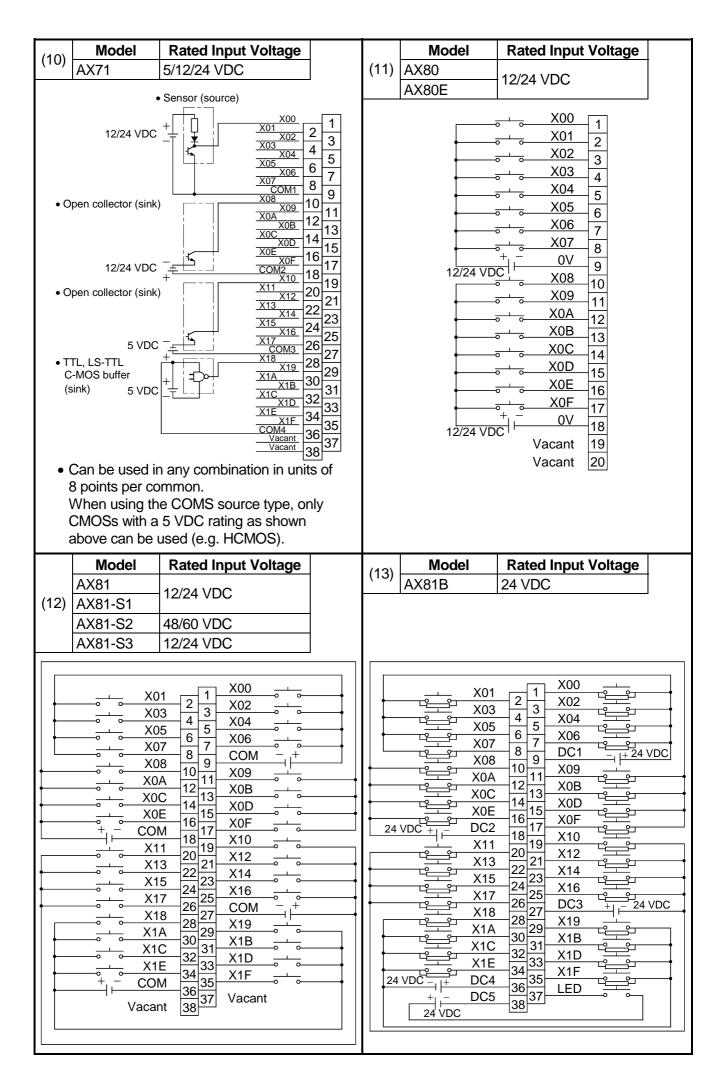
*3: The number of simultaneous input points is 40% (13 inputs/common) simultaneously ON when the unit is used adjacent to the power supply module.

5.1.2 Input module connections

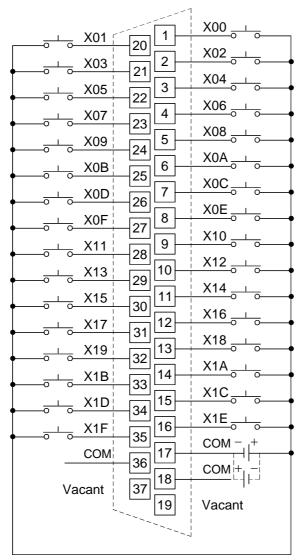






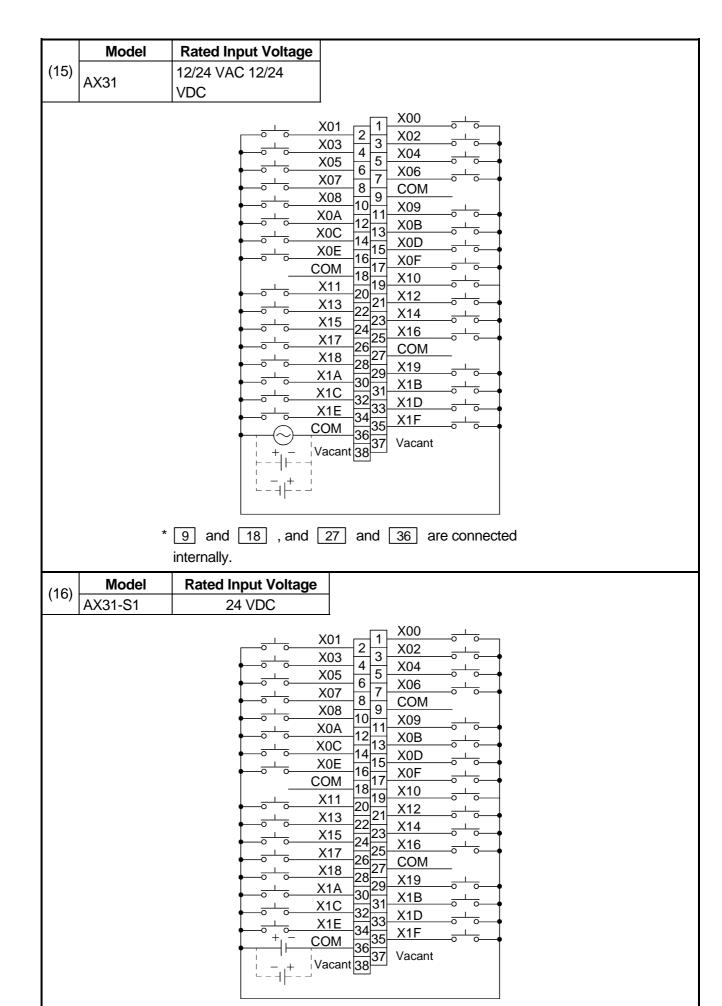


(14) Model Rated Input Voltage
AX82 12/24 VDC



- * The figure above indicates F (the first half 35 points).

 The connections for L (the latter half 32 points) are the same as for F (regard X00 to X1F as X20 to X3F).
 - 17, 18, and 36 are connected internally.



* 9 and 18 , and 27 and 36 are connected

55

internally.

5.2 Output Modules

5.2.1 Output module specifications

Model	Output Type	No. of Points/	Rated Load Voltage	Max. Loa	d Current	Input Response Time			
		Module		Per Point	Per Common	OFF to ON	ON to OFF		
AY10	Contact output		240VAC		8A		12msec or less		
AY10A	Contact output (All points independent)				16A/all points	10msec			
AY11	Contact output	16 points			8A				
AY11A	Contact output		24VAC		16A/all	or less			
AY11AEU	(All points independent)				points	-			
AY11E	, , , ,								
AY11EEU	-				8A				
AY13	Contact output				5A				
AY13E	_	32 points							
AY13EEU AY15EU		24 points			8A				
7111000		Z+ points			O/ C				
AY20EU		16 points		0.6A	1.9A				
							0.5Hz		
AY22	Triac output		100 to 200 VAC	2A	3.3A	1msec or less	+ 1msec		
AY23		32 points		0.6A	2.4A *4 (1.05A)		or less		
AY40	Transistor output (sink type) Transistor output (all points independent sink type)			0.1A	0.8A				
AY40A		16 points	12/24VDC	0.3A	_	2msec or less	2msec or less (resistive load)		
AY40P	Transistor output (sink type)				0.1A	0.8A			

	External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC)	Internal Current Consumption	Number of Occupied I/O Points
	20 terminal block connector 38 terminal block connector	8 points/ common No common (all points independent)	None	- None	None SA None	0.15A	0.115A 0.23A	16 points
	20 terminal block connector 38 terminal block connector	8 points/ common No common (all points independent)	- Varistor					
	20 terminal block connector	8 points/ common		8A				
	38 terminal block connector		None	None 8A		0.29A		32 points
	38 terminal block connector	4 points/ common	CR absorber	3.2A	Display		0.4A	16 points
	20 terminal block connector		CR absorber varistor	7A *6	Display *10	_	0.305A	16 points
	38 terminal block connector	8 points/common No common (all points independent)	Absorber	3.2A *6 None None		0.59A	32 points	
	20 terminal block connector		Clamp diode		None	0.008A	0.115A	
	38 terminal block connector		Surge absorbing diode			_	0.19A	16 points
	20 terminal block connector	8 points/ common	Cramp diode			0.015A	0.115A	

(To next page)

Model	Output Type	No. of Points/	Rated Load	Max. Loa	d Current	Input Response Time	
		Module	Voltage	Per Point	Per Common	OFF to ON	ON to OFF
AY41					1.6A		
AY41P		32 points		0.1A	1A		2msec or less (resistiv e load)
AY42 *1				0.1A	2A *4		
4Y42-S1 1					(1.6A)		
AY42-S3 *1		64 points		0.1A *5	2A		
AY42-S4 *1	Transistor output (sink type)			0.1A	1.92A	2msec or less	
AY50		16 points		0.5A	2A		
AY51		32 points			2A *4		
					(3.3A)		
Y51-S1				0.3A	2A		
4Y60				2A	5A		
AY60E	Transistor output		24VDC (12/48V) *2	12/24 VDC 2A 48VDC 0.8A	ЗА		
	(source type)	16 points	12/24VDC	12VDC 2A	9.6A	0.5msec	1.5msec or less
AY60EP		. o ponito		24VDC 0.8A	3.8A	or less	
AY60S	Transistor output (sink type)		24/48VDC (12V) *3	2A	6.4A	1msec or less	3msec or less (resistive load)
AY70		16 points		0.016A	0.128A		
AY71	Transistor output (for TTL. COMOS) (sink type)	32 points	5/12VDC	0.016A	0.256A	1msec or less	1msec or less
AY72 *1	(Sillik type)	64 points		0.016A	0.512A		

	External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
	38 terminal block connector	16 points/ common	Cramp diode	None	None	0.02A 0.03A	0.23A	32 points
			Cramp diode	None	None	0.04A	0.34A 0.23A	32 points
	40-pin connector ×	32 points/		1.6A *7	Display *11		0.29A	
	2	Common	Photo coupler Built-in Zener diode	None	None		0.5A	64 points
	20 terminal block connector	8 points/ common	Varistor	2A *6	Display *10	0.065A	0.115A	16 points
	38 terminal block connector	16 points/ common		None	None	0.05A	0.023A	32 points
			Transistor Built-in Zener diode	1A *8	Display *10	0.1A	0.31A	
·		8 points/ common	Varistor	3.2A *9		0.065A	0.115A 0.075A	16 points
			Surge absorbing diode	5A *9	Display	0.065A		
	20 terminal block connector			None	*9 None	0.11A		
			Varistor	5A *9		0.003A		
			None			*12 0.055A	0.1A	16 points
	38 terminal block connector	16 points/ common		None		*12 0.1A	0.2A	32 points
	40-pin connector × 2	32 points/ common				*12 0.3A	0.3A	64 points

(To next page)

(From front page)

Model	Output Type	No. of Points/ Module	Rated Load Voltage	Max. Load Current		Input Response Time	
				Per Point	Per Common	OFF to ON	ON to OFF
AY80	Transistor output (source type)	16 points	12/24VDC	0.5A	2A	2msec of less	2msec of less (resistive load)
AY80EP	(Source type)			0.8A	3.84A	0.5msec or less	1.5msec or less
AY81		32 points	12/24VDC	0.5A	4A	2msec of less	2msec of less (resistive load)
AY81EP	Transistor output			12VDC 0.8A	7.68A	0.5msec or less	
*1	(source type)			24VDC 0.4A	3.84A		1.5msec or less
		04		12VDC 0.1A	1.92A		
AY82EP		64 points		24VDC 0.04A	0.758A		

	External Connections	Common Terminal Arrangement	Surge Suppression	Fuse Rating	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
	20 terminal block	8 points/	Varistor	2A *6	Display *10	0.06A	0.115A	16 points
	connector	common	Surge absorbing diode	None	None	0.11A		
	38 terminal block connector	16 points/ common	Varistor	None		0.05A	- 0.23A	32 points
			Surge absorbing		None	0.22A		
	40-pin connector × 2	32 points/ common	diode			0.05A	0.29A	64 points

The following specifications apply to all modules:

Isolation method : Photocoupler

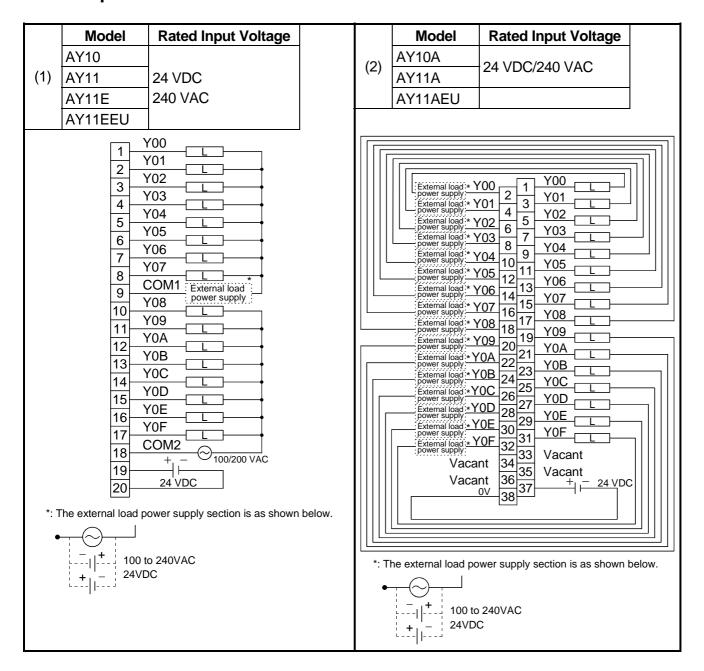
Input indication : LEDs

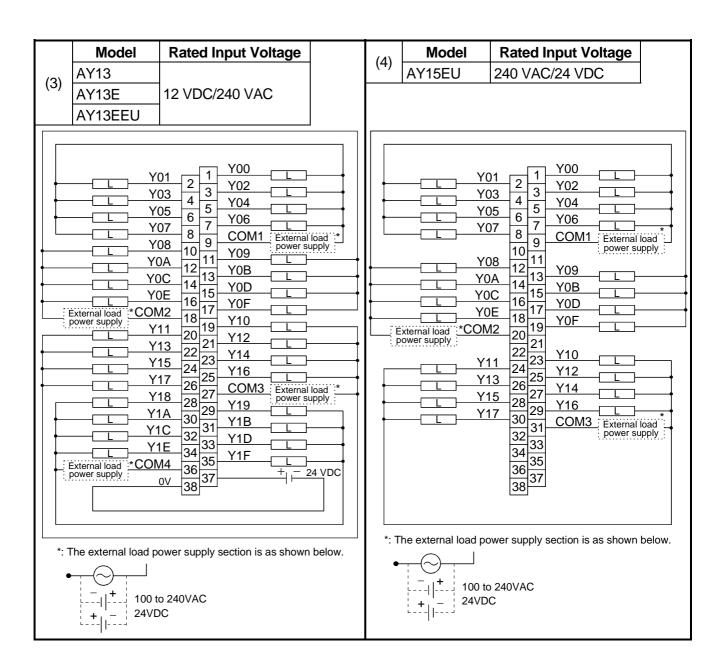
*1 : The ON/OFF status of the first or latter half is indicated by the LEDs in accordance with the setting of the selector switch on the front panel of the module:

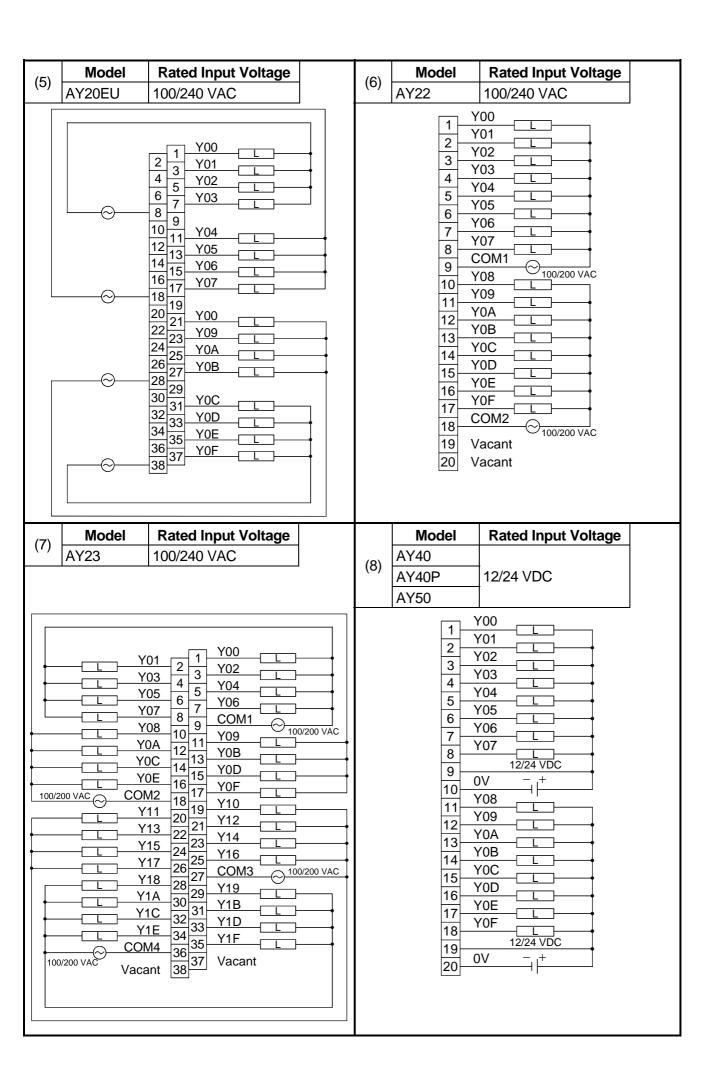
FH setting: First half (X00 to X1F), LH setting: Latter half (X20 to X3F)

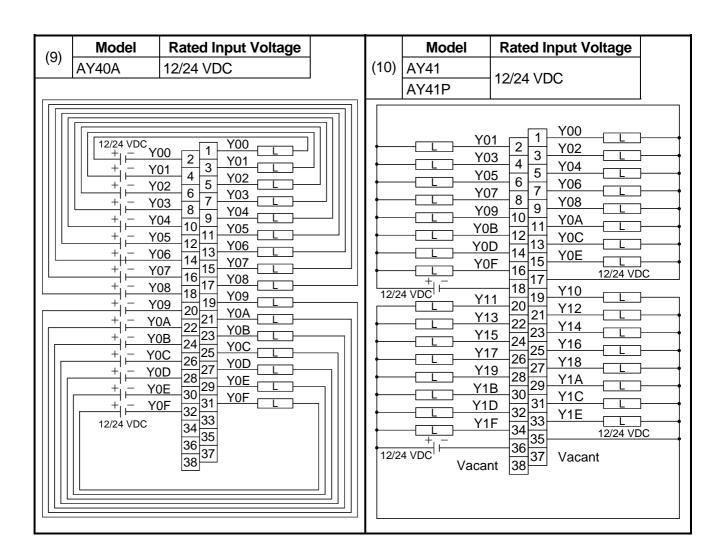
- *2 : When 12/48 VDC is used as the load power supply, a separate 24 VDC power supply must be used as an external power supply.
- *3 : When 12 VDC is used as the load power supply, a separate 24/48 VDC power supply must be used as an external power supply.
- *4 : When the module is installed adjacent to the power supply module, the value indicated in parentheses applies.
- *5 : The maximum load current differs depending on the number of simultaneously ON points.
- *6 : Fast-melting fuse (one per common)
- *7 : Normal fuse (two per common)
- *8 : Fast-melting fuse (two per 8-per-common unit)
- *9 : Fast-melting fuse (two per common)
- *10: LED comes on when a fuse blows or the external power supply is turned off.
- *11: Since this is a built-in fuse directly fixed to the module, replace the entire module if it blows.
- *12: TYP. 12 VDC

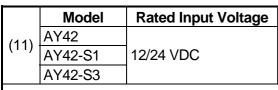
5.2.2 Output module connections

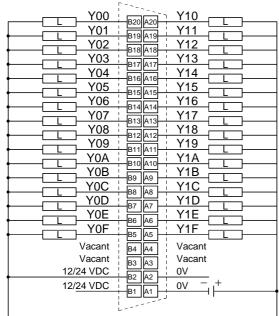










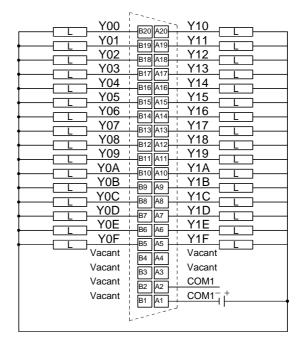


* The figure above indicates F (the first half 32 points).

The connections for L (the latter half 32 points) are the same as for F (regard Y00 to Y1F as Y20 to Y3F).

B1 and B2 , and A1 and A2 are connected internally.

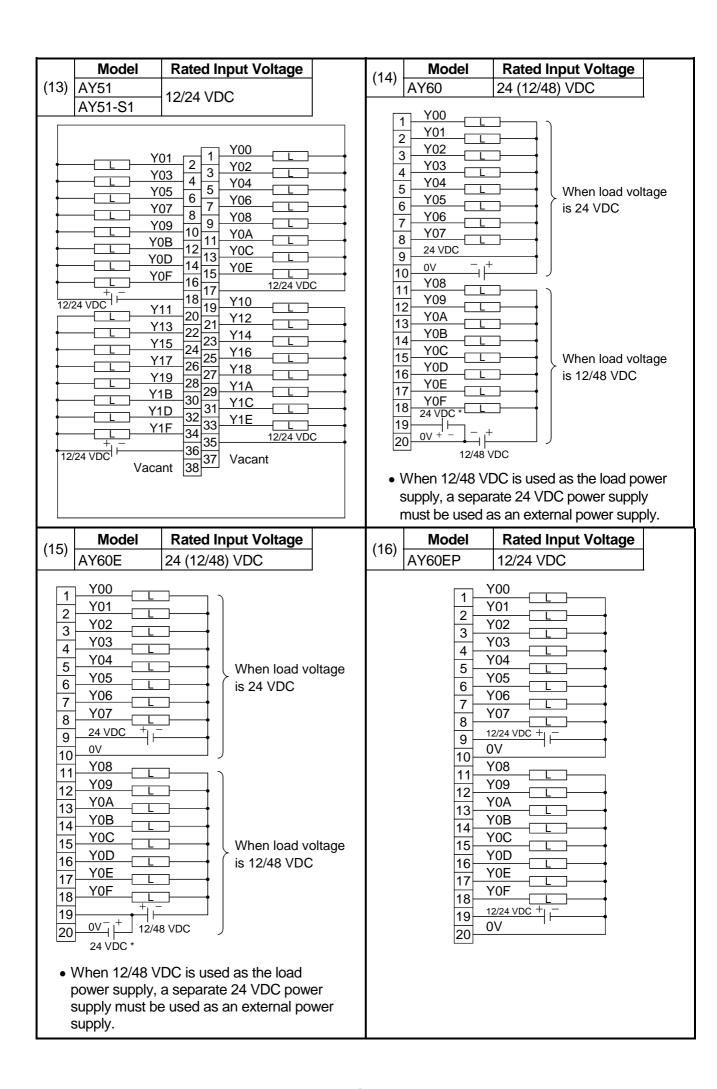
(12)	Model	Rated Input Voltage				
(12)	AY42-S4	12/24 VDC				

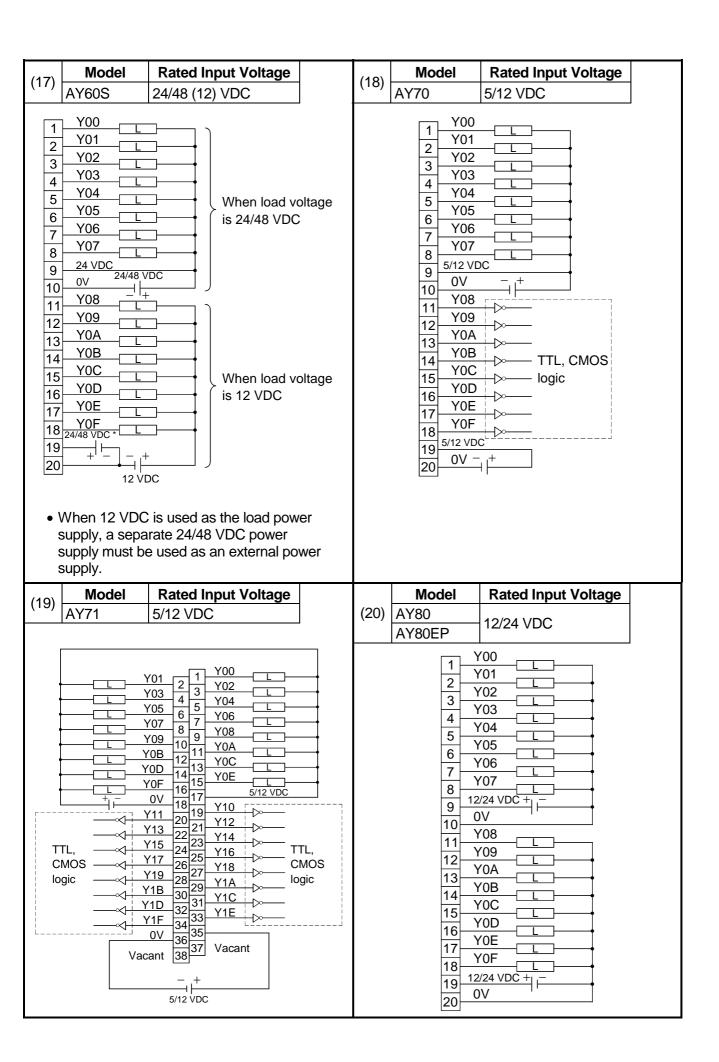


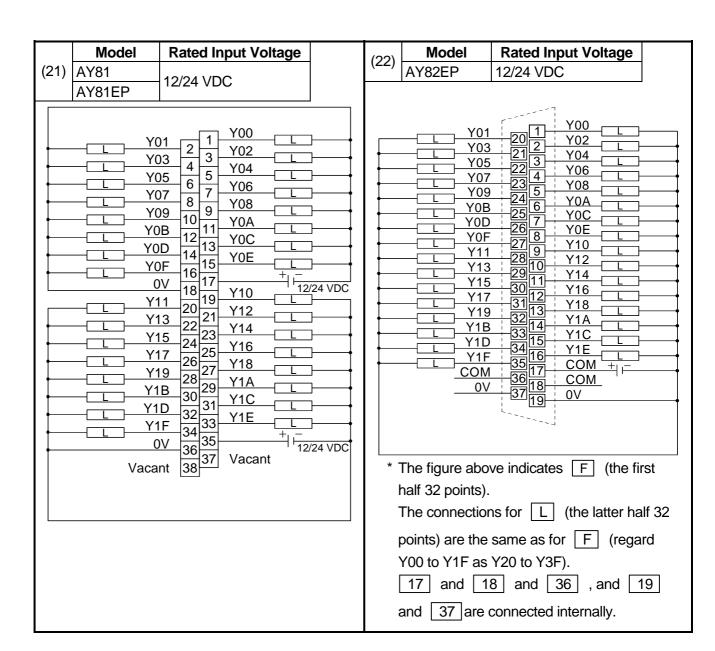
* The figure above indicates F (the first half 32 points).

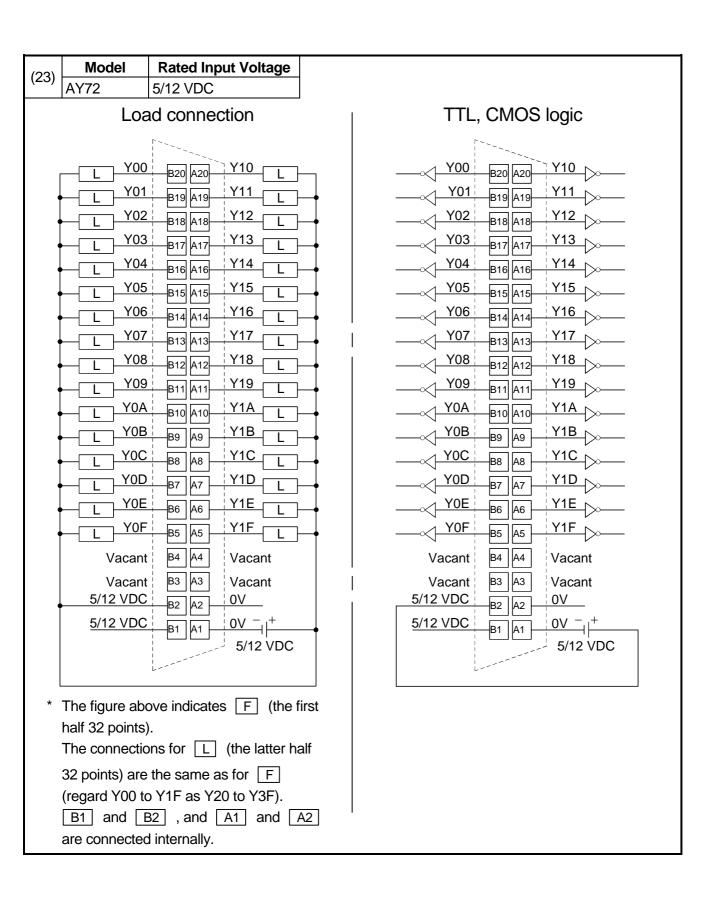
The connections for L (the latter half 32 points) are the same as for F (regard Y00 to Y1F as Y20 to Y3F). Regard COM1 as COM2.

B1 and B2 , and A1 and A2 are connected internally.









MEMO			

5.3 Input/Output Combined Modules

5.3.1 Input/output combined module specifications

		Number				Operating Voltage		
Model	Input Type	of Points/ Module	Isolation Method	Rated Input Voltage	Input Current	ON Voltage	OFF Voltage	
A42XY	Dynamic scan	64 points *1	Photocoupler	10/04)/50		7VDC or higher	3VDC or lower	
AH42	DC input (sink type)	32 points	insulation	12/24VDC	3/7mA	9.5VDC or higher	6VDC or lower	

Model	Output Type	No. of Points/ Module	Rated Load Voltage	Max. Loa	d Current	Input Resp	oonse Time	
		Wodule		Per Point	Per Common	OFF to ON	ON to OFF	
A42XY	Dynamic scan	64 points		50mA	_	16msec or less	16msec or less	
AH42	Transistor output (sink type)	32 points	12/24VDC	0.1A	1A	2msec or less	2msec or less	

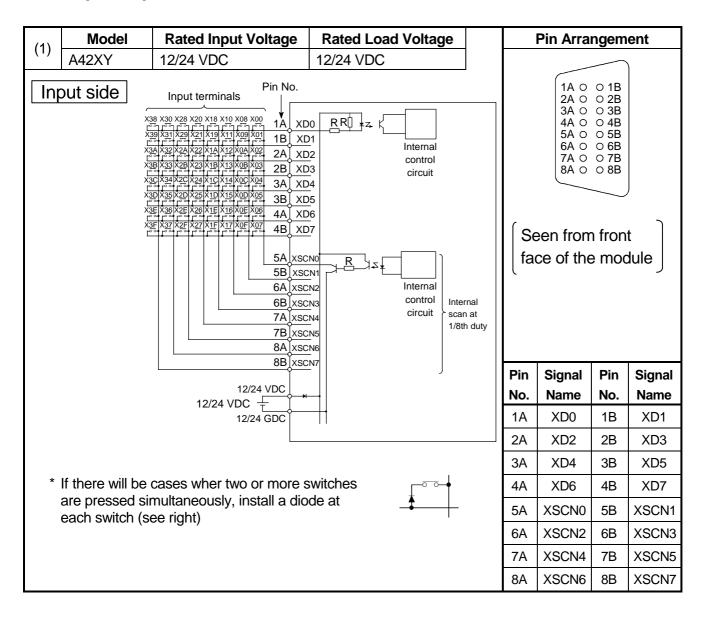
	Maximum	Input Resp	onse Time			Common Terminal Arrangement	
	Simultaneous ON Input Point (Percentage Simultaneous ON)	OFF to ON	ON to OFF	Input Display	External Connections		
		16msec or	16msec or		16-pin connector		
	60%	less	less	LED display	To pill confidence		
		10msec or	10msec or	LLD display	40-pin connector	30 points/	
		less	less		× 2	common	

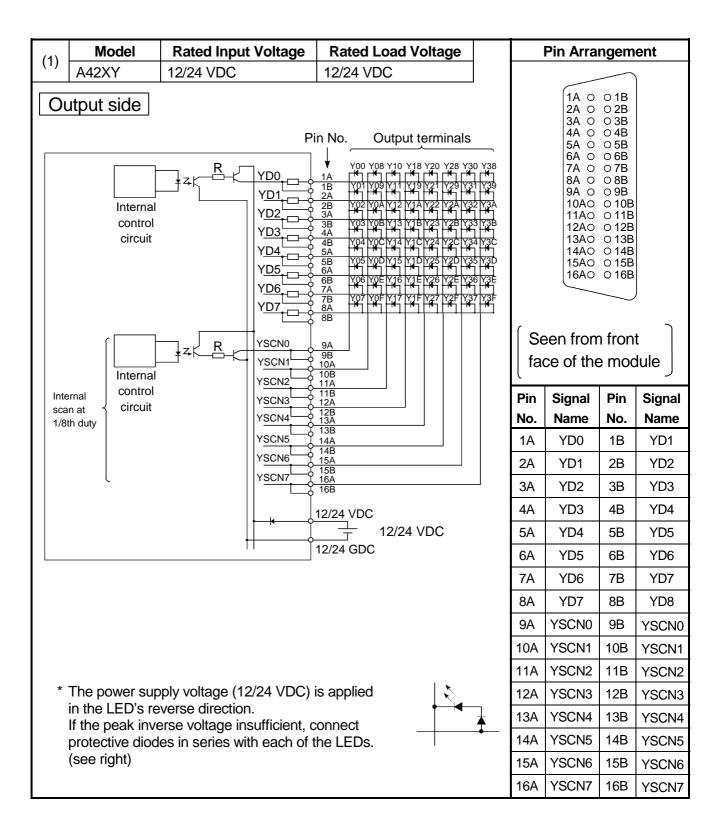
External Connections	Terminai	Surge Suppression	Fuse Ratting	Error Display	External Power Supply (TYP 24VDC) Current	Internal Current Consumption	Number of Occupied I/O Points
32-pin connector	_	None			0.18A	0.11A	64 points *1
40-pin connector × 2	32 points/ common	Clamp diode	None	None	0.04A	0.245A	64 points *2

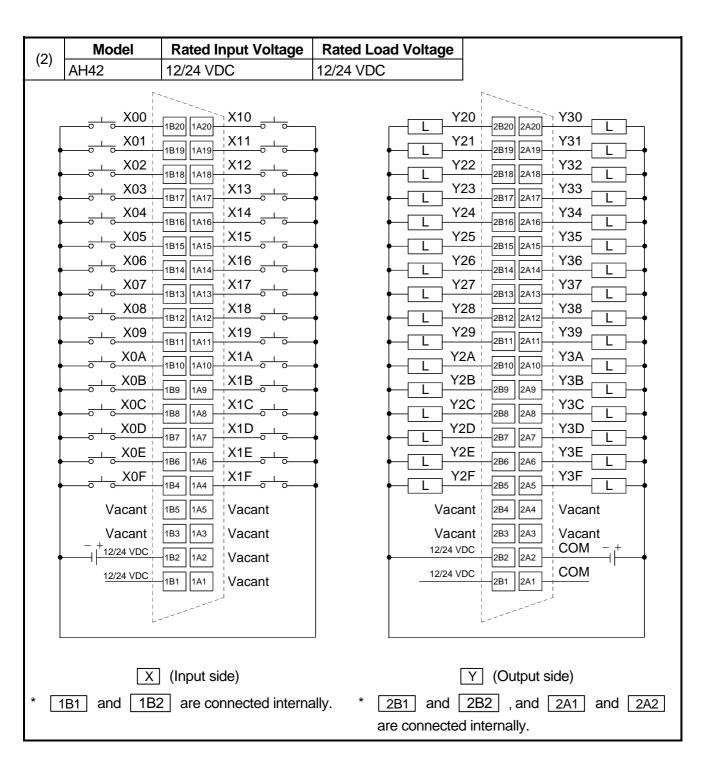
^{*1 :} The same numbers are allocated to both input and output points. The number of occupied I/O points is 64.

^{*2 :} The first half 32 points are allocated to input and the latter half 32 points are allocated to output. Thus, the number of occupied I/O points is 64. When I/O allocation is carried out at a peripheral device, both modules should be set as 64-point output modules.

5.3.2 Input/output combined module connections







6. ERROR CODE

When a programmable controller error occurs at power ON, when switched to the RUN status, or during the RUN status, the self-diagnosis function displays the error content (by LED indicator, or message display), and stores the error information at a special replay (SM) and special register (SD).

QnACPU errors and corrective actions are described in this chapter.

REMARK

The error code of the error that occurred when a general data processing request is made from the peripheral device, special function module or network system is not stored into SD0 of the QnACPU.

The error code is returned to the source of the general data processing request.

6.1 Error Code Readout Procedure

When an error occurs, the error code or error message, etc., can be read out at GPP function. For details regarding the GPP function operation procedure, refer to the GX Developer OPERATING MANUAL or SW□IVD-GPPQ OPERATING MANUAL.

6.2 Error Code List

The following information deals with error codes and the meanings, causes, and corrective measures of error messages.

"O" in the Corresponding CPU column indicates that the error is applied to all types of CPUs. "Rem" indicates compatibility with the remote I/O module. A CPU type name in the column indicates that the error is applied only to the specific CPU type.

			11 /			71		
Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic	
(SD0) * 1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing	
1000				Off	Flicker/ On	Stop	Always	
1001								1
1002								
1003								
1004	-							
1005								
1006	MAIN CPU				Flicker	Stop		
1007	DOWN			Off			Always	
1008				Oii	1 HOROI		Aiways	
1009								
1010								
1011								
1012	END NOT EXECUTE			Off	Flicker	Stop	When an END instruction is executed.	
1101								
1102	RAM ERROR			Off	Flicker	Stop	At power ON/At reset	
1103								
1104	_							

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU MODULE operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

	Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	1000			0
	1001 1002	Run mode suspended or failure of main	Measure noise level.Reset the CPU module and RUN it	QCPU
	1003 1004	CPU (1) Malfunctioning due to noise or other	again. If the same error is displayed again,	QCPU
	1005	reason (2) Hardware fault	this suggests a CPU module hardware error. Contact your nearest Mitsubishi	QCPU Rem
	1006 1007		representative.	QCPU
•	1008			
	1009	The fault of the power supply module, CPU module, main base unit, extension base unit or extension cable was detected.	Reset the CPU module and RUN it again. If the same error is displayed again, the power supply module, CPU module, main base unit, extension base unit or extension cable is faulty. Contact your nearest Mitsubishi representative.	Serial No. 04101 or later
	1010	Entire program was executed without	Measure noise level.	
	1011	the execution of an END instruction.	Reset the CPU module and RUN it	
	1012	(1) When the END instruction is executed it is read as another instruction code, e.g. due to noise.(2) The END instruction has been changed to another instruction code somehow.	again. If the same error is displayed again, this suggests a CPU module hardware error. Contact your nearest Mitsubishi representative.	0
	1101	Error in internal RAM/program memory where CPU module sequence program is stored.	This suggests a CPU module hardware	
	1102	Error in RAM used as CPU module work area.	error. Contact your nearest Mitsubishi representative.	0
	1103	Internal CPU module device memory error.	пергезептануе.	
	1104	RAM Address error in the CPU module.		

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code List (Continued)									
Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic		
(SD0) * 1	Messages	Information	Information	RUN	ERROR	Statuses of	Timing		
(== =,	g	(SD5 to 15) * 1	(SD16 to 26) *1	11011	Littort	CPU	9		
1105	RAM ERROR			Off	Flicker	Stop	At power ON/At reset		
1200									
1201	OPE. CIRCUIT			Off	Flicker	Stop	At power		
1202	ERR.				G ii	ono.	Otop	ON/At reset	
1203							When an END		
1204	OPE.						instruction executed.		
1205	CIRCUIT ERR.	CUIT ——		Off	Flicker	r Stop	executed.		
1206							When instruction executed.		
1300	FUSE BREAK OFF	Unit No.		Off/ON	Flicker/ On	Stop/ Continue *2	When an END instruction is executed.		

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU MODULE operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corresponding CPU
	System RAM fault in the CPU module	This suggests a CPU module hardware error. Contact your nearest Mitsubishi representative.	Q4AR
1105	CPU shared memory fault in the CPU module	 Measure noise level. Reset the CPU module and RUN it again. If the same error is displayed again, this suggests a CPU module hardware error. Contact your nearest Mitsubishi representative. 	QCPU function Ver. B or later
1200	The circuit that performs CPU internal index is not operating properly.		
1201	Internal CPU module hardware (logic) does not operate normally.	This suggests a CPU module hardware error. Contact your nearest Mitsubishi	0
1202	The circuit that executes sequence processing in the CPU module does not operate properly.	representative.	
1203	The operation circuit that conducts index modification in the CPU module is not operating properly.		Q4AR
1204	The hardware (logic) in the CPU us not operating properly.	This suggests a CPU module hardware	
1205	The operation circuit that conducts sequence processing in the CPU in not operating properly.	error. Contact your nearest Mitsubishi representative.	
1206	The DSP operation circuit in the CPU is not operating properly.		
1300	There is an output module with a blown fuse.	 Check FUSE. LED of the output modules and replace the module whose LED is lit. Read the common information of the error using the peripheral device and replace the fuse at the output module corresponding to the numerical value (module No.) reading. Alternatively, monitor special registers SD1300 to SD1331 with the peripheral device and change the fuse of the output module whose bit has a value of "1". When a display device is connected to the main base unit or extension base unit, check the connection status of the extension cable and the earth status of the display device. 	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

			Code List (Co			r	r	1
Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic	
(SD0) * 1	Messages	Information	Information	RUN	ERROR	Statuses of	Timing	
(000) 1	Weedagee	(SD5 to 15) * 1	(SD16 to 26) *1	IXOIN	LINION	CPU	riiiiig	
1300	FUSE BREAK OFF	Unit No.		Off/ON	Flicker/ On	Stop/ Continue *2	When an END instruction is executed.	
	I/O INT ERROR			Off	Flicker	Stop	During interrupt	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU MODULE operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	There is an output module with a blown fuse.	 Check ERR. LED of the output modules and replace the fuse of the module whose LED is lit. Read the common information of the error using the peripheral device and replace the fuse at the output module corresponding to the numerical value (module No.) reading. Alternatively, monitor special registers SD1300 to SD1331 with the peripheral device and change the fuse of the output module whose bit has a value of "1". When a display device is connected to the main base unit or extension base unit, check the connection status of the extension cable and the earth status of the display device. 	QnA Q4AR
1300	(1) There is an output module with a blown fuse.(2) External power supply for output load is turned off or disconnected.	 Check ERR. LED of the output modules and replace the module whose LED is lit. Read the common information of the error using the peripheral device and replace the fuse at the output module corresponding to the numerical value (module No.) reading. Alternatively, monitor special registers SD1300 to SD1331 with the peripheral device and change the fuse of the output module whose bit has a value of "1". Check whether the external power supply for output load is ON or OFF. When a display device is connected to the main base unit or extension base unit, check the connection status of the extension cable and the earth status of the display device. 	
1310	An interruption has occurred although there is no interrupt module.	One of the individual modules is experiencing hardware problems, so check the modules. Contact your nearest Mitsubishi representative and explain the problem with the defective module.	0

st 1 Characters in parentheses () indicate the special register numbers where individual information is being stored.

	1	1	Code List (Col		,	T _	T T
Error Code (SD0) *1	Error Messages	Common Information	Individual Information	DLIN	Status ERROR	Operating Statuses of CPU	Diagnostic Timing
4404	SP. UNIT	(SD5 to 15) *1	(SD16 to 26) *1		Flicker/	Stop/	At power ON/At reset/ When intelligent function module is accessed.
1401	DOWN	Unit No.		Off/On	On	Continue	At power ON/At reset
1402	SP. UNIT	Unit No.	Program error location	Off/On	Flicker/	Stop/ Continue	When an intelligent function module access instruction is executed. During execution of
	DOWN	Office NO.		Oll/Oll	On	*6	FROM/TO instruction set.
1403							When an END instruction is executed.
1411	CONTROL -BUS ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset
1412			Program error location				During execution of FROM/TO instruction set.

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored

^{*6} Stop/continue operation is selectable for each module by setting parameters.

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	(1) There was no response from the intelligent function module during initial communication stage.(2) The size of the buffer memory of the intelligent function module is wrong.	This suggests a CPU module hardware error. Contact your nearest Mitsubishi representative.	QCPU Rem
1401	When parameter I/O allocation was being made, there was no return signal from the special function module during initial processing stage. When error is generated, the head I/O number of the special function module that corresponds to the common information is stored.	The special function module that was being accessed is experiencing hardware error. Contact your nearest Mitsubishi representative.	QnA
	The intelligent function module was accessed in the program, but there was no response.	This suggests a CPU module hardware error. Contact your nearest Mitsubishi representative.	QCPU Rem
1402	The special function module was accessed during the execution of a FROM/TO instruction set, but there was no response. When an error is generated, the program error location corresponding to the individual information is stored.	The special function module that was being accessed is experiencing hardware error. Contact your nearest Mitsubishi representative.	QnA
1403	(1) There was no response from the intelligent function module when the END instruction is executed.(2) An error is detected at the intelligent function module.	The intelligent function module that was being accessed is experiencing hardware error. Contact your nearest Mitsubishi representative.	QCPU Rem
1411	When performing a parameter I/O allocation a special function module could not be accessed during initial communications. On error occurring, the head I/O number of the corresponding special function module is stored in the common information.	Reset the CPU module and RUN it again. If the same error is displayed again, the intelligent function module/special function module, CPU	O Rem
1412	The FROM/TO instruction set could not be executed, due to a system bus error with a special function module. On error occurring, the program error location is stored in the individual information.	module or base unit is faulty. Contact your nearest Mitsubishi representative.	0

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Codo	Error	Common	Individual		Status	Operating	Diagnostia	
Error Code (SD0) *1	Error Messages	Information	Information (SD16 to 26) *1	DLIN	ERROR	Statuses of CPU	Diagnostic Timing	
1413	CONTROL -BUS. ERR.			Off	Flicker	Stop	Always	
1414	CONTROL -BUS. ERR.	Unit No.		Off	Flicker	Stop	When an END instruction is executed.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
1413	In a multiple CPU system configuration, the High Performance model QCPU of function version A was mounted.	 Remove the High Performance model QCPU of function version A from the main base unit. Alternatively, replace the High Performance model QCPU of function version A with the High Performance model QCPU of function version B. Iternatively, replace the High Performance model QCPU of function version A with the High Performance model QCPU of function version B. An intelligent function module, CPU module or the base unit is experiencing error. Contact your nearest Mitsubishi representative. 	QCPU function Ver. B or later
	An error is detected on the system bus. (1) Self-diagnosis error of the system bus. (2) Self-diagnosis error of the CPU module	Reset the CPU module and RUN it again. If the same error is displayed again, the intelligent function module, CPU module or base unit is faulty. Contact your nearest Mitsubishi representative.	QCPU Rem
1414	 (1) Fault of the loaded module was detected. (2) In a multiple PLC system configuration, the High Performance model QCPU of function version A was mounted. 	Remove the High Performance model QCPU of function version A from the main base unit. Alternatively, replace the High Performance model QCPU of function version A with the High Performance model QCPU of function version B. Alternatively, replace the High Performance model QCPU of function	QCPU function Ver. B or later
	An error is detected on the system bus.	A special function module, the CPU module, or base unit is experiencing error. Contact your nearest Mitsubishi representative.	QCPU Rem

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing	
1415	CONTROL -BUS.	Base No.		Off	Flicker	Stop	When an END instruction is executed	
1416	ERR.	Unit No.					At power ON/At reset	
1421	SYS. UNIT DOWN * 3			Off	Flicker	Stop	Always	
1500	AC/DC DOWN			On	Off	Continue	Always	
1510	DUAL DC DOWN 5V * 4			On	On	Continue	Always	
1520	DC DOWN 5V * 5			Off	Flicker	Stop	Always	
1530	DC DOWN 24V * 3			On	On	Continue	Always	
1600	BATTERY	Drive Name		On	On	Continue	Always	
1601	ERROR			BAT.A	LM LED			
1602					On			

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*3} This can only be detected in redundant systems. Detection is possible in either the control system or the standby system.

^{*4} This can only be detected in the redundant system control system.
*5 This can be detected in either a standalone system or a redundant system. However, in a redundant system it can only be detected in the control system.

Err Coo (SD0)	de	Error Contents and Cause	Corrective Action	Corres- ponding CPU	
141	15	Fault of the main or extension base unit was detected.	An intelligent function module, the CPU module, or the base unit is experiencing error. Contact your nearest Mitsubishi	QCPU function Ver. B	
141	16	System bus fault was detected at PLC power-on or CPU module reset.	representative.	or later	
142	21	Hardware fault at the system management module AS92R.	 Since it suggests the hardware fault of the system management module AS92R Contact your nearest Mitsubishi representative. 	Q4AR	
150	00	(1) A momentary power supply interruption has occurred.(2) The power supply went off.	Check the power supply.	O Rem	
151	10	The power supply voltage (100 - 240VAC) of either of the two power supply modules on the power supply duplexing extension base unit dropped to or below 85% of the rated voltage.	Check the supply voltage of the power supply module. If the voltage is abnormal then replace the power supply		
152	20	The power supply voltage(100 - 240VAC) of the power supply module on the extension base unit dropped to or below 85% of the rated voltage.	module.	Q4AR	
153	30	The 24 VDC power supplied to the system management module AS92R has dropped below 90% of the rated voltage.	Check the 24VDC power supplied to the system management module AS92R.		
160	00	(1) Voltage in the CPU module battery has dropped below stipulated level.(2) The CPU module battery is not connected.	 Change the battery. If the battery is for program memory, standard RAM or for the back-up power function, install a lead connector. 	0	
160	01	Voltage of the battery on memory card 1 has dropped below stipulated level.	Change the battery.		
160	02	Voltage of the battery on memory card 2 has dropped below stipulated level.	Change the battery.	QnA	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	Г		Jode List (Cor				T	
Error Code		Common Information	Individual Information		Status	Operating Statuses of	Diagnostic	
(SD0) *1	Messages	(SD5 to 15) * 1	(SD16 to 26) *1	RUN	ERROR	CPU	Timing	
2000	UNIT VERIFY ERR.	Unit No.		Off/On	Flicker/ On	Stop/ Continue *2	When an END instruction is executed.	
2100	SP. UNIT LAY ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

*2 The CPU MODULE operation status when an error occurs can be set at the parameters. (LED

display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	The High Performance model QCPU of function version A was loaded in a multiple CPU system configuration.	Change the High Performance model QCPU of function version A for the High Performance model QCPU of function version B.	QCPU function Ver. B or later
2000	I/O module information power ON is changed. I/O module (or special function module) not installed properly or installed on the base unit.	 Read the common information of the error using the peripheral device, and check and/or change the module that corresponds to the numerical value (module number) there. Alternatively, monitor the special registers SD1400 to SD1431 at a peripheral device, and change the fuse at the output module whose bit has a value of "1". When a display device is connected to the main base unit or extension base unit, check the connection status of the extension cable and the earth status of the display device. 	Kem
	Slot loaded with the QI60 is set to other than the Inteli (intelligent function module) or Interrupt (interrupt module) in the parameter I/O assignment.	Make setting again to match the parameter I/O assignment with the actual loading status.	QCPU function Ver. B or later
2100	 In the parameter I/O allocation settings, an Inteli (intelligent function module) was allocated to a location reserved for an I/O module or vice versa. In the parameter I/O allocation settings, a module other than CPU (or nothing) was allocated to a location reserved for a CPU module or vice versa. A general-purpose switch was set to the module with no general-purpose switches. 	 Reset the parameter I/O allocation setting to conform to the actual status of the intelligent function module and the CPU module. Delete the general-purpose switch settings. 	QCPU Rem
	In parameter I/O allocation settings, a special function module was allocated to a location reserved for an I/O module. Or, the opposite has happened.	Reset the parameter I/O allocation setting to conform with the actual status of the special function modules.	QnA

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

		ſ	JOGC LIST (OOI			T _	1	I
Error Code (SD0) *1	Error Messages	Common Information	Individual Information	DUN	Status ERROR	Operating Statuses of	Diagnostic Timing	
2101	SP. UNIT LAY ERR.	(SD5 to 15) * 1 Unit No.	(SD16 to 26) *1	Off	Flicker	CPU Stop	At power ON/At reset	
2102								
2103	SP. UNIT LAY ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	
2104								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
2101	13 or more A-series special function modules (except for the A1SI61) that can initiate an interrupt to the CPU module have been installed.	Reduce the A series special function modules (except the A1SI61) that can make an interrupt start to the CPU module to 12 or less.	QCPU
2101	13 or more special function modules (not counting the A(1S)I61) capable of sending an interrupt to the CPU module have been installed.	Keep the number of special function modules that can initiate an interrupt (with the exception of the A(1S)I61 module) to 12 or fewer.	QnA
	7 or more A1SD51S have been installed.	Keep the number of A1SD51S to 6 or fewer.	QCPU
2102	7 or more serial communication modules (excludes A (1S) J71QC24) have been installed.	Keep the number of serial communication modules (excludes A(1S)J71QU24) installed to 6 or fewer.	QnA Rem
2103	 2 or more QI60/A1SI61 modules are loaded in a single CPU system. 2 or more QI60/A1SI61 modules are set to the same control CPU in a multiple CPU system. 2 or more A1SI61 modules are loaded in a multiple CPU system. 	 Reduce the number of QI60/A1SI61 modules loaded in the single CPU system to one. Change the number of QI60/A1SI61 modules set to the same control CPU to only one in the multiple CPU 	QCPU function Ver. B or later
	2 or more QI60, A1SI61 interrupt modules have been installed.	Install only 1 QI60, A(1S)I61 module.	QCPU
	The QI60 is loaded. 2 or more A1SI61 interrupt modules have been installed.	Remove the QI60. Install only 1 AI61 module.	Rem QnA
	At the MELSECNET/MINI auto refresh parameter settings, the module allocation that was set is different from the actual module models at the station numbers in the link system.	Reset the parameter MELSECNET/MINI auto refresh unit module allocation setting so that it conforms to the station number of the module that is actually linked.	QnA

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

			Jude List (COI		-	Operation		
Error Code	Error	Common Information	Individual Information		Status	Operating Statuses of	Diagnostic	
(SD0) *1	Messages	(SD5 to 15) * 1	(SD16 to 26) *1	RUN	ERROR	CPU	Timing	
2105	SP. UNIT LAY ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	
2106								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
2105	There are too many special function modules that can use dedicated instructions allocated (number of modules installed). (The total of the figures indicated below is above 1344.) (Number of AD59 modules installed × 5) (Number of AD57 (S1)/AD58 modules installed × 8) (Number of AJ71C24 (S3/S6/S8) modules installed × 10) (Number of AJ71UC24 modules installed × 10) (Number of AJ71C21 (S1) modules installed × 29) (Number of AJ71PT32-S3/ AJ71T32-S3 modules installed × 125)* (Number of AJ71QC24 (R2, R4) modules installed × 29) (Number of AJ71ID1 (2)-R4 modules installed × 8) (Number of AD75 modules installed × 12) Total > 1344	Reduce the number of special function modules installed. *: When the expansion mode is used.	QnA
	(1) 5 or more MELSECNET/H modules are loaded in a whole multiple CPU system.(2) 5 or more Q series Ethernet interface modules are loaded in a whole multiple CPU system.	 Reduce the MELSECNET/H modules to 4 or less in the whole multiple CPU system. Reduce the Q series Ethernet modules to 4 or less in the whole multiple CPU system. 	QCPU function Ver. B or later
2106	 (1) 5 or more MELSECNET/H modules have been installed. (2) 5 or more Q series Ethernet interface modules have been installed. (3) The same network numbers or station numbers exist, in the MELSECNET/10 network system. 	 Reduce the MELSECNET/H modules to 4 or less. Reduce the Q series Ethernet modules to 4 or less. Check the network numbers and station numbers. 	Rem

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error Messages	Common	Individual Information (SD16 to 26) *1	LED Status		Operating	Diagnostic	
(SD0) *1		Information		DLIN	ERROR	Statuses of CPU	Timing	
2106								
2107	SP. UNIT LAY ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	
2108								
2109 * 6								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

*6 Stop/continue operation is selectable for each module by setting parameters.

C	Error Code D0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
2	2106	 (1) 5 or more AJ71QLP21 & AJ71QBR11 modules are installed. (2) 3 or more AJ71AP21/R21 & AJ71AT21B modules are installed. (3) The total number of installed AJ71QLP21, AJ71QBR11, AJ71AP21/R21, and AJ71AT21B modules exceeds 5. (4) The same network numbers or identical station numbers exist in the MELSECNET/10 network system. (5) 2 or more master or load stations exist simultaneously at the MELSECNET(II) or MELSECNET/B data link system. 	 Reduce the AJ71QLP21 and AJ71QBR11 modules to 4 or less. Reduce the AJ71AP21/R21 and AJ71AT21B modules to 2 or less. Reduce the AJ71QLP21, AJ71QBR11, AJ71AP21/R21 and AJ71AT21B modules to a total of 4 or less. Check the network Nos. and station Nos. Check the station Nos. 	QnA
2	2107	Head X/Y set in the parameter I/O allocation settings is also the head X/Y for another module.	Reset the parameter I/O allocation setting to conform with the actual status of the special function modules.	O Rem
2	2108	 (1) Network module A1SJ71LP21, A1SJ71BR11, A1SJ71AP21, A1SJ71AR21, or A1SJ71AT2B dedicated for the A2USCPU has been installed. (2) Network module A1SJ71QLP21 or A1SJ71QBR11 dedicated for the Q2AS has been installed. 	Change network module to MELSECNET/H module.	QCPU
		A(1S)J71LP21 or A(1S)J71BR11 for use with the AnUCPU network module has been installed.	Change network module to A(1S)J71QBR11.	QnA
	2109	The control system and standby system module configurations are different when a redundant system is in the backup mode.	Check the module configuration of the standby system.	Q4AR

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	1	ı	Code List (Coi		,		
Error Code (SD0) *1	Error Messages	Common Information (SD5 to 15) * 1	Individual Information (SD16 to 26) *1	DLIN	Status ERROR	Operating Statuses of CPU	Diagnostic Timing
2110	SP. UNIT ERROR	Unit No.	Program error location	Off/On	Flicker/ On	Stop/	When instruction executed.
2111	SP. UNIT ERROR	Unit No.	Program error location	Off/On	Flicker/ On	Stop/ Continue * 2	When instruction executed.
2112	SP. UNIT ERROR	Unit No.	Program error location	Off/On	Flicker/ On	•	When instruction executed/STOP → RUN
2113		FFFFн (fixed)					
2114	SP. UNIT ERROR	Unit No.	Program error location	Off/On	Flicker/ On	Continue/ Stop	When instruction is executed

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU MODULE operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	Station not loaded was specified using the instruction whose target was the CPU share memory.	Read the individual information of the error using the peripheral device, check the program corresponding that value (program error location), and make correction.	QCPU function Ver. B or later
2110	(1) The location designated by the FROM/TO instruction set is not a special function module.(2) The special function module, Network module being accessed is faulty.	 Read the individual information of the error using the peripheral device, then check and edit the FROM/TO instruction set that corresponds to the numerical value there (Program error location). The special function module that is being accessed has a hardware error. Consult your nearest Mltsubishi representative. 	0
2111	The location designated by a link direct device (J□¥□) is not a network module.	Read the individual information of, then check and edit the FROM/TO instruction set that corresponds to the numerical value there (Program error	0
2112	 (1) The module specified in the special function module dedicated instruction is not a special function module. Alternatively, it is not the corresponding special function module. (2) The network No. specified in the network dedicated instruction does not exist, or the relay target network does not exist. (3) Alternatively, it is not the relevant special function module. 	Read individual information of the error using the peripheral device, then check and edit the special function module (Network module) dedicated instruction that corresponds to the numerical value there (program error location).	O Rem
2113	The one specified in the network-dedicated instruction is not a network module.		0
2114	An instruction, which on execution specifies other stations, has been used for specifying the host CPU. (An instruction that does not allow the host CPU to be specified).	Read the individual information of the error using the peripheral dervice, check the program corresponding that value (program error location), and make correction.	QCPU function Ver. B or later

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Г.,		Common	Individual		Status	Operating	Diameratia	
Error Code (SD0) *1	Error Messages	Information	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Diagnostic Timing	
2115								
	SP. UNIT ERROR	Unit No.	Program error location	Off/On	Flicker/ On		When instruction is executed	
2117								
2120								
2121								
2122								
	SP. UNIT LAY ERR.			Off	Flicker	Stop	At power ON/At reset	
2125								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
2115	An instruction, which on execution specifies the host CPU, has been used for specifying other CPUs. (An instruction that does not allow other stations to be specified).		
2116	(1) An instruction that does not allow the under the control of another CPU to be specified is being used for a similar task.(2) Instruction was executed for the A or QnA module under control of another CPU.	Read the individual information of the error using the peripheral dervice, check the program corresponding that value (program error location), and make correction.	QCPU function Ver. B or later
2117	A CPU module that cannot be specified in the instruction dedicated to the multiple CPU system was specified.		
2120	The location of Q□B and QA1S□B is improper.	Check the location of the base unit.	
2121	The CPU module is installed at other than the CPU slot or slots 0 to 2.	Check the loading position of the CPU module and reinstall it at the correct slot.	
2122	QA1S B is used to the main base unit.	Use Q3_B as the main base unit.	
2124	 (1) A module is installed at 65th or higher slot. (2) A module is installed at the slot later than the number of slots specified with base allocation setting. (3) A module is installed at the I/O points later than the 4,096th point. (4) A module installed at the 4,096th point occupies higher points. 	 Remove the module installed at 65th or later slot. Remove the module installed at the slot later than the number of slots specified with base allocation setting. Remove the module installed at the I/O points later than the 4,096th point. Change the last module to a module which does not exceed the 4,096th point. 	QCPU Rem
2125	(1) A module which the QCPU cannot recognise has been installed.(2) There was no response form the intelligent function module.	 Install a module which can be used with the CPU module. The intelligent function module is experiencing hardware problems. Contact your nearest Mitsubishi representative. 	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common	Individual		Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	DLIN	ERROR	Statuses of CPU	Timing	
2126	SP. UNIT LAY ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	
2150	SP. UNIT VER. ERR.	Unit No.		Off	Flicker	Stop	At power ON/At reset	
2200	MISSING PARA.	File name/ drive name		Off	Flicker	Stop	At power ON/At reset	
2210	BOOT ERROR	File name/ drive name		Off	Flicker	Stop	At power ON/At reset	
2300	ICM. OPE. ERROR	File name/ drive name		Off/On	Flicker/ On	Stop/ Continue * 2	When memory card is inserted or removed	
2301	ICM. OPE. ERROR	File name/ drive		Off/On	Flicker/ On	Stop/ Continue	When memory card is inserted	
2302						*2	or removed	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Co	rror ode 0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
21	126	CPU module locations in a multiple CPU system are either of the following. (1) There are empty slots between the QCPU and QCPU/motion controller. (2) A module other than the High Performance model QCPU/Process CPU (including the motion controller) is mounted on the left-hand side of the High Performance model QCPU/Process CPU.	 Eliminate empty slots between the CPU modules. (Set empty slots on the right side of the CPU modules.) Dismount the module other than the QCPU mounted between the High Performance model QCPUs/Process CPUs and replace it with the High Performance model QCPU/Process CPU. Load the motion controller on the right side of the QCPUs. 	QCPU function Ver. B or later
21		In a multiple CPU system, the control CPU of the intelligent function module incompatible with the multiple CPU system is set to other than CPU No.1.	 Change the intelligent function module for the one compatible with the multiple CPU system (function version B). Change the setting of the control CPU of the intelligent function module incompatible with the multiple CPU system to CPU No.1. 	
22		There is no parameter file at the drive designated by DIP switches as a valid drive.	 Check and correct the setting of the parameter enabled drive switch. Put a parameter file in the drive designated by the parameter enabled drive switch. 	0
		The contents of the boot file are incorrect.	Check the boot setting.	QCPU
22		There is no boot file in the drive designated by the parameter enabled drive switch even though the Boot DIP switch is ON.	 Check and correct the setting of the parameter enabled drive switch. Put a boot file in the drive designated by the parameter enabled drive switch. 	QnA
23	300	(1) A memory card was removed without switching the memory card in/out switch OFF.(2) The memory card in/out switch is turned ON although a memory card is not actually installed.	 Remove memory card after placing the memory card in/out switch OFF. Turn on the card insert switch after inserting a memory card. 	0
23	301	(1) The memory card has not been formatted.(2) Memory card format status is incorrect.	Format memory card. Reformat memory card.	0
23		A memory card that cannot be used with the CPU module has been installed.	Check memory card.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	Г	1	Sode Fist (Col		•	1		
Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing	
2400	FILE SET ERROR	File name/ drive name		Off	Flicker	Stop	At power ON/At reset	
2401	FILE SET ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/At reset	
2402								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0)	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	Automatic write to standard ROM was performed on the CPU module that is incompatible with automatic write to standard ROM. (Memory card where automatic write to standard ROM was selected in the boot file was fitted and the parameter enable drive was set to the memory card.)	 Execute automatic write to standard ROM on the CPU module which is compatible with automatic write to standard ROM. Using GX Developer, perform write of parameters and programs to standard ROM. Change the memory card for the one where automatic write to standard ROM has not been set, and perform boot operation from the memory card. 	QCPU function Ver. B or later
2400	The file designated at the PLC file settings in the parameters cannot be found.	Read the individual information of the error using peripheral device, check to be sure that the parameter drive name and file name correspond to the numerical values there (parameter number), and correct. Create a file created using parameters, and load it to the CPU module.	0
	The Ethernet parameter that was added for QnACPU, with the function version "B," has been set to QnACPU without the function version "B."	Change to QnACPU with the function version "B". Delete the Ethernet parameter.	QnA
2404	Program memory capacity was exceeded by performing boot operation or automatic write to standard ROM.	 Check and correct the parameters (boot setting). Delete unnecessary files in the program memory. Choose "Clear program memory" for boot in the parameter so that boot is started after the program memory is cleared. 	QCPU function Ver. B or later
2401	The file designated at the parameter PLC RAS settings fault history area has not been created.	Read the individual information of the error using the peripheral device, check to be sure that the parameter drive name and file name correspond to the numerical values there (parameter number), and correct. Check the space remaining in the memory card.	0
2402	Though the file register has been set in the pairing setting/tracking setting, the file register does not exist.	Confirm the file register and parameter.	Q4AR

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

		i	Individual			Operating		
Error Code (SD0) *1	Error Messages	Common Information (SD5 to 15) * 1	Individual Information (SD16 to 26) *1	DLIN	Status ERROR	Operating Statuses of CPU	Diagnostic Timing	
2410								
2411	FILE OPE. ERROR	File name/drive name	Program error location	Off/On	Flicker/ ON	Stop/ Continue * 2	When instruction is executed	
2412								
2413								
2500								
2501	CAN'T EXE. PRG.	File name/drive name		Off	Flicker	Stop	At power ON/At reset	
2502								
2503								
2504								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

being stored.

*2 The CPU MODULE operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Erro Code (SD0)	e Error Contents and Cause	Corrective Action	Corresponding CPU
2410	the program memory.	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct. Create a file created using parameters, and load it to the CPU module.	
241	occur when the ECALL, EFCALL, PSTOP, PSCAN, POFF or PLOW instruction is executed.	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct.	0
2412	The SFC program file is one that cannot be designated by the sequence program.	iodation), and correct.	
2413	No data has been written to the file designated by the sequence program.	Read the individual information of the error using the peripheral device, check to be sure that the program corresponds to the numerical values there (program location), and correct. Check to ensure that the designated file has not been write protected.	
2500	There is a program file that uses a device that exceeds the device allocation range designated by the parameter device settings.	Read the common information of the error using the peripheral device, check to be sure that the parameter device allocation setting and the program file device allocation correspond to the numerical values there (file name), and correct if necessary.	0
250	There are multiple program files although "none" has been set at the parameter program settings.	Edit the parameter program setting to "yes". Alternatively, delete unneeded programs.	
2502	The program file is incorrect. Alternatively, the file contents are not those of a sequence program.	Check whether the program version is ***.QPG, and check the file contents to be sure they are for a sequence program.	
2500	ı ü	Check program configuration.	
2504	Two or more SFC normal programs or control programs have been designated.	Check parameters and program configuration.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common	Individual		Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing	
3000	PARAMET ER ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3001								
3002								
	PARAMET ER ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	When an END instruction is executed.	
3003	PARAMET ER ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3004	PARAMET ER ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	In a multiple CPU system, the intelligent function module under control of another CPU is specified in the interrupt pointer setting of the parameter.	intelligent function module under	QCPU function Ver. B or later
3000	The parameter settings for timer time limit setting, the RUN-PAUSE contact, the common pointer number, the general data processing, number of vacant slots, or system interrupt settings are outside the range that can be used by the CPU module.	Read the detailed information of the error using the peripheral device, check the parameter items corresponding to the numerical values (parameter numbers) there, and correct when necessary. If the error is still generated following.	O Rem
3001	Parameter contents have been destroyed.	If the error is still generated following the correction of the parameter settings, it is likely that there is a	
3002	When "use the following files" is selected for the file registers in the PLC file setting parameter, the specified file does not exist though the file register capacity has been set.	memory error, either in the internal CPU RAM/program memory or on the memory card. Contact your nearest Mitsubishi representative.	0
	The automatic refresh range of the multiple CPU system exceeded the file register capacity.	Change the file register file for the one refresh-enabled in the whole range.	QCPU function Ver. B or later
3003	The number of devices set at the parameter device settings exceeds the possible CPU module range.	 Read the detailed information of the error using the peripheral device, check the parameter items corresponding to the numerical values (parameter numbers) there, and correct when necessary. If the error is still generated following the correction of the parameter settings, it is likely that there is a memory error, either in the internal CPU RAM/program memory or on the memory card. Contact your nearest Mitsubishi representative. 	0
3004	not parameters.	Check whether the parameter file version is * * * .QPA, and check the file contents to be sure they are parameters.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

		1	Sode Fist (Col			1		,
Error Code	Error	Common	Individual	LED	Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing	
3006								
3009	PARAMET ER ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3010							KON	
3012								
3013								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
3006	 (1) The high speed interrupt parameter is set in a Q02CPU. (2) The high speed parameter is set in a multiple CPU system. (3) The high speed interrupt parameter is set when a QA1S B or QAB is used. (4) No module is installed at the I/O address designated by the high speed interrupt parameter. 	 Delete the setting of the Q02CPU's high speed interrupt parameter. To use high speed interrupts, change the CPU module to one of the Q02H/Q06H/Q12H/Q25HCPU. To use a multiple CPU system, delete the setting of the high-speed interrupt parameter. To use high speed interrupts, change the system to a single CPU system. To use either the QA1S B or QAB, delete the setting of the high speed interrupt parameter. To use high speed interrupt parameter. To use high speed interrupts, do not use the QA1S B/QAB. Re-examine the I/O address designated by the high speed interrupt parameter. 	QCPU serial No. 04012 or later
3009	In a multiple CPU system, the modules for AnS, A, Q2AS and QnA have been set to multiple control CPUs.	Re-set the parameter I/O assignment to control them under one QCPU. (Change the parameters of all CPUs in the multiple CPU system.)	
3010	The parameter-set number of CPU modules differs from the actual number in a multiple CPU system.	Match (preset count of multiple CPU setting) - (CPU (empty) setting in I/O assignment) with the actual number of CPUs loaded.	
3012	Multiple CPU setting or control CPU setting differs from that of the reference CPU in a multiple CPU system.	Match the multiple CPU setting or control CPU setting in the parameter with that of the reference CPU (CPU No.1).	QCPU function Ver. B
3013	Multiple CPU automatic refresh setting is any of the followings in a multiple CPU system. (1) When a bit device is specified as a refresh device, a number other than a multiple of 16 is specified for the refresh-starting device. (2) The device specified is other than the one that may be specified. (3) The number of send points is an odd number.	Check the following in the multiple CPU automatic refresh parameters and make correction. • When specifying the bit device, specify a multiple of 16 for the refresh starting device. • Specify the device that may be specified for the refresh device. • Set the number of send points to an even number.	or later

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

		Common	Individual		<u>/</u> Status	Operating		
Error Code (SD0) *1	Error Messages	Information (SD5 to 15) * 1	Individual Information (SD16 to 26) *1	DUN	ERROR	Ctatuage of	Diagnostic Timing	
3100	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code D0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	In a multiple CPU system, the MELSECNET/H under control of another CPU is specified as the head I/O number in the network setting parameter of the MELSECNET/H.	 Delete the MELSECNET/H network parameter of the MELSECNET/H under control of another CPU. Change the setting to the head I/O number of the MELSECNET/H under control of the host CPU. 	QCPU function
The network parameters of the MELSECNET/H operating in the ordinary station were rewritten to the control station, or the network parameters of the MELSECNET/H operating in the control station were rewritten to the ordinary station. (The network parameters are reflected on the module side by making a reservant of the station of the module side by making a reservant of the station of the module side of the station of the st		Reset the CPU module.	Ver. B or later
3100	 (1) The number of actually installed modules is different from that designated in the number of modules setting parameter of MELSECNET/H. (2) The head I/O number of actually installed modules is different from that designated in the network parameter of MELSECNET/H. (3) Some data in the parameter cannot be handled. (4) The station type of MELSECNET/H has been changed while the power is on. (RESET → RUN is required to change the station type.) 	 Check the network parameters and mounting status, and if they differ, match the network parameters and mounting status. If any network parameter has been corrected, write it to the CPU module. Confirm the setting of the number of extension stages of the extension base units. Check the connection status of the extension base units and connectors. When a display device is connected to the main base unit or extension base unit, check the connection status. If the error occurs after the above checks have been made, it suggests a hardware fault. Contact your nearest Mitsubishi representative. 	QCPU
	Although the QnACPU is a control station or master station, the network parameters have not been written.	 Correct and write the network parameters. If the error occurs after correction, it suggests a hardware fault. Contact your nearest Mitsubishi representative. cial register numbers where individual info 	QnA

st 1 Characters in parentheses () indicate the special register numbers where individual information is being stored.

E 0 1	_	Common	Individual		Status	Operating	D: (:	
Error Code (SD0) *1	Error Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Diagnostic Timing	
	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	When an END instruction is executed.	
3101	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3102								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0)	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	The link refresh range exceeded the file register capacity.	Change the file register file for the one that enables entire range refresh.	QCPU function Ver. B or later
	 (1) When the station number of the MELSECNET/H module is 0, the inter-PLC network parameter setting has been made. (2) When the station number of the MELSECNET/H module is other than 0, the remote master parameter setting has been made. 	Correct the type or station number of the MELSECNET/H module in the parameter to meet the used system.	
3101	 (1) The network No. specified by a parameter is different from that of the actually mounted network. (2) The head I/O No. specified by a parameter is different from that of the actually mounted I/O unit. (3) The network class specified by a parameter is different from that of the actually mounted network. (4) The network refresh parameter of the MELSECNET/H, MELSECNET/10 is out of the specified area. 	 Check the network parameters and mounting status, and if they differ, match the network parameters and mounting status. If any network parameter has been corrected, write it to the CPU module. Confirm the setting of the number of extension stages of the extension base units. Check the connection status of the extension base units and connectors. When a display device is connected to the main base unit or extension base unit, check the connection status. If the error occurs after the above checks have been made, it suggests a hardware fault. Contact your nearest Mitsubishi representative. 	0
3102	An error was discovered when the network parameter check was made at the network module. The parameters specific to MELSECNET/H and MELSECNET/10 are not normal.	 Write after correcting network parameters. If the error persists after corrections have been made, contact your nearest Mitsubishi representative. 	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common	Individual		Status	Operating	Diagnostic	
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	DLIN	ERROR	Statuson of	Timing	
3103	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3104								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	In a multiple CPU system, the Q series Ethernet interface module under control of another station is specified as the head I/O number of the Ethernet setting parameter.	 Delete the Ethernet setting parameter of the Q series Ethernet interface module under control of another station. Change the setting to the head I/O number of the Q series Ethernet interface module under control of the host station. 	QCPU function Ver. B or later
3103	 Though the number of Ethernet module is set to one or more in the parameter, the actually mounted number of units is zero. The head I/O number for the Ethernet module set parameter is different from that of the actually mounted module. 	 Write after correcting network parameters. If the error persists after corrections have been made, contact your nearest Mitsubishi representative. 	O Rem
	 AJ71QE71 does not exist in the position of I/O number set by the parameter. I/O number designation is overlapping. Numbers of the parameter and loaded AJ71QE71 are different. (4) Ethernet (parameter + dedicated instruction) is set to more than 5. 	 Write after correcting network parameters. If the error persists after corrections have been made, contact your nearest Mitsubishi representative. 	QnA
3104	 (1) Ethernet and MELSECNET/10 use the same network number. (2) Network number, station number or group number set by the parameter is out of range. (3) The I/O No. is specified for the used CPU module. (4) The Ethernet-specific parameter setting is not normal. 	 Write after correcting network parameters. If the error persists after corrections have been made, contact your nearest Mitsubishi representative. 	O Rem

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	Common Lestificates LED Otation Constitution							
Error Code		Common Information	Individual Information		Status	Operating Statuses of	Diagnostic	
(SD0) *1	Messages		(SD16 to 26) *1	RUN	ERROR	CPU	Timing	
3105	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
2400	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	When an END instruction is executed.	
3106	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
	LINK PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3200								
3201	SFC	File name/drive	Parameter	Ott	☐!:=!::=::	Cto	STOP →	
3202	PARA. ERROR	name	number	Off	Flicker	Stop	RUN	
3203								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

(Error Code D0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
		In a multiple CPU system, the Q series CC-Link module under control of another station is specified as the head I/O number of the CC-Link setting parameter.	 Delete the CC-Link setting parameter of the Q series CC-Link module under control of another station. Change the setting to the head I/O number of the Q series CC-Link module under control of the host station. 	QCPU function Ver. B or later
	3105	 Though the number of CC-Link module set in the network parameters is one or more, the actually mounted number of units is zero. The head I/O number in the common parameters is different from that of the actually mounted module. The station class for the CC-Link module quantity set parameters is different from that of the actually mounted station. 	Write after correcting network parameters. If the error persists after corrections have been made, contact your nearest Mitsubishi representative.	O Rem
		The contents of the Ethernet parameter are incorrect.	Write after correcting parameters.	QnA
		The CC-Link link refresh range	Change the file register file for the one refresh-enabled in the whole range.	QCPU function Ver. B or later
		The network refresh parameter for CC-Link is out of range.	Check the parameter setting.	QCPU Rem
;	.5107 1	The CC-Link link refresh range exceeded the file register capacity. Change the file register file for the one refresh-enabled in the whole range. Check the parameter setting. Check the parameter setting. Check the parameter setting. Check the parameter setting.	O Rem	
	3200	The parameter setting is illegal. (1) Though Block 0 was set to "Automatic start" in the SFC setting of the PLC parameter dialog box, Block 0 does not exist.	Read the common information of the	
_;	3201	The block parameter setting is illegal.	error using the peripheral device, check error step corresponding to its numerical	
;		The number of step relays designated in the parameters is less than the number used by the program.	value (program error location), and correct the problem.	0
;		The execution type set for an SFC program in the parameters is other than the scan execution type.	nial register numbers where individual info	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Codo	Error	Common	Individual		Status	Operating	Diognostic	
Error Code (SD0) *1	Error Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	DLIN	ERROR	Statuses of CPU	Diagnostic Timing	
3300							At power ON/Reset/ STOP → RUN	
2204	SP. PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	When an END instruction is executed.	
3301							At power ON/Reset/ STOP → RUN	
3302								
3303	SP. PARA. ERROR	File name/drive name	Parameter number	Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	
3400								
3401	REMOTE PASS. ERROR			Off	Flicker	Stop	At power ON/Reset/ STOP → RUN	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
3300	The head I/O number in the intelligent function module parameter set on GX Configurator differs from the actual I/O number.	Check the parameter setting.	QCPU Rem
3301	The refresh setting of the intelligent function module exceeded the file register capacity.	Change the file register file for the one which allows refresh in the whole range.	QCPU function Ver. B or later
	The intelligent function module's refresh parameter setting is outside the available range.	Check the parameter setting.	QCPU Rem
3302	The intelligent function module's refresh parameter are abnormal.	Check the parameter setting.	QCPU
3303	In a multiple CPU system, automatic refresh setting or similar parameter setting was made to the intelligent function module under control of another station.	 Delete the automatic refresh setting or similar parameter setting of the intelligent function module under control of another CPU. Change the setting to the automatic refresh setting or similar parameter setting of the intelligent function module under control of the host CPU. 	
3400	The head I/O number of the target module in the remote password file is set to other than 0H to 0FF0H.	Change the head I/O number of the target module to within the 0H to 0FF0H range.	
3401	Position specified as the head I/O number of the remote password file is incorrect due to one of the following reasons: (1) Module is not loaded. (2) Other than a Q-compatible intelligent function module (I/O, A, QnA module) (3) Intelligent function module other than the Q series serial communication module, modem interface module or Ethernet module (4) Q series serial communication module or Ethernet module of function version A	Mount the Q series serial communication module, modem interface module or Ethernet module of function version B in the position specified in the head I/O No. of the remote password file.	QCPU function Ver. B or later
	The Q series serial communication module, modem interface module or Ethernet module of function version B controlled by another CPU was specified in a multiple CPU system.	 Change it for the Ethernet module of function version B connected by the host CPU. Delete the remote password setting. 	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	T	i	Jadisidual		•	On a ratio		
Error Code		Common Information	Individual Information		Status	Operating Statuses of	Diagnostic	
(SD0) *1	Messages		(SD16 to 26) *1	RUN	ERROR	CPU	Timing	
4000								
4001								
4002	INSTRCT CODE ERR.	Program error location		Off	Flicker		At power ON/Reset/ STOP → RUN	
4003								
4004								
4010	MISSING END INS.	Program error location		Off	Flicker	Stop		
4020	CAN'T SET (P)	Program error location		Off	Flicker	Stop	At power ON/Reset/ STOP →	
4021							RUN	
4030	CAN'T SET (I)	Program error location		Off	Flicker	Stop		
4100								
4101	OPERATI ON ERROR	Program error location		Off	Flicker	continue	When instruction is executed	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is

being stored.

*2 The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
4000	(1) The program contains an instruction code that cannot be decoded.(2) An unusable instruction is included in the program.		0
4001	The program contains a dedicated instruction for SFC although it is not an SFC program.		
4002	 (1) The extension instruction designated by the program has an incorrect instruction name. (2) The extension instruction specified in the program cannot be executed by the specified module. 	Read the common information of the	0
4003	devices.	error step corresponding to its numerical value (program error location), and	Rem
4004	The extension instruction designated by the program a device which cannot be used.	correct the problem.	
4010	There is no END (FEND) instruction in the program.		
4020	The total number of internal file pointers used by the program exceeds the number of internal file pointers set in the parameters.		0
4021	The common pointer numbers used by individual files overlap.		
4030	The allocation pointer numbers used by individual files are overlap.		
4100	The instruction cannot process the contained data.		
4101	 The designated device number for data processed by the instruction exceeds the usable range. Alternatively, the stored data or constants for the devices designated by the instruction exceeds the usable range. 	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	Kem

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

		Common	Individual		Status	Operating		
Error Code (SD0) *1	Error Messages	Information	Individual Information (SD16 to 26) *1	DLIN	ERROR	Operating Statuses of CPU	Diagnostic Timing	
4102								
4103	OPERATI ON	Program error location		Off	Flicker	continue	When instruction is	
4104	ERROR					*2	executed	
4107								
4108								
4109								
	FOR NEXT ERROR	Program error location		Off	Flicker	Stop	When instruction is executed	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
	In a multiple CPU system, the link direct device (J□¥G□) was specified for the network module under control of another station.	 Delete from the program the link direct device which specifies the network module under control of another CPU. Using the link direct device, specify the network module under control of the host CPU. 	QCPU function Ver. B or later
4102	The network number and station number designated with a dedicated network instruction are not correct. The link direct device (J [] ¥W []) is not set correctly. • The module No./network No./character string count specified by the extension instruction is outside the setting range. • The character string (" ") specified by the extension instruction is unusable.	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	O Rem
4103	The configuration of the PID dedicated instruction is incorrect.		0
4104	The number of settings is beyond the range.	Read the common information of the error using peripheral device, and check and correct the program corresponding to that value (program error location).	Q4AR
4107	33 or more multiple CPU dedicated instructions were executed from one CPU module.	Using the multiple CPU dedicated instruction completion bit, provide interlocks to prevent one CPU module from executing 32 or more multiple CPU dedicated instructions.	QCPU function Ver. B or later
4108	Numbers of execution to the CC-Link instruction are beyond 32. The CC-Link parameter is not set when the CC-Link instruction is executed.	Set the numbers of execution to the CC-Link instruction to 32 or less. Execute the CC-Link instruction after setting the CC-Link parameter.	QnA
4109	With high speed interrupt setting execute PR/PRC,UDCNT1, UDCONT2, PLSY, PWM,SPD,PLOADP,PUNLOADP,PAW PP instruction.	Delete the high-speed interrupt parameter setting. When using high-speed interrupt, delete the PR, PRC, UDCNT1, UDCNT2, PLSY, PWM, SPD, PLOAD, PUNLOAD and PSWAP instructions.	QCPU serial No. 04012 or later
4200	No NEXT instruction was executed following the execution of a FOR instruction. Alternatively, there are fewer NEXT instructions than FOR instructions.	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	0

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common	Individual		Status	Operating	Diagnostic
(SD0) *1	Messages	Information (SD5 to 15)	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Timing
4201							When
4202	FOR NEXT ERROR	Program error location		Off	Flicker	Stop	instruction is executed
4203							C.Accuted
4210							
4211	CAN'T EXECUTE (P)			Off	Off Flicker	er Stop	When instruction is
4212		(P)					executed
4213							
4220	CAN'T	Program orror					When
4221	EXECUTE	Program error location		Off	Flicker	er Stop	instruction is executed
4223							
4230							
4231	INST.						When
4235	FORMAT ERR.	Program error location		Off	Flicker	Stop	instruction is executed
4300	EXTEND INST.	Program error location		Off/On	Flicker/ On	Stop/ continue	When instruction is
4301	ERR.	iocation			011	*2	executed

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
4201	A NEXT instruction was executed although no FOR instruction has been executed. Alternatively, there are more NEXT instructions than FOR instructions.	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	
4202	More than 16 nesting levels are programmed.	Keep nesting levels at 16 or under.	0
4203	A BREAK instruction was executed although no FOR instruction has been executed prior to that.	Read the common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	
4210	The CALL instruction is executed, but there is no subroutine at the specified pointer.	Read the common information of the error using the peripheral device, check	
4211	There was no RET instruction in the executed sub-routine program.	error step corresponding to its numerical value (program error location), and	0
4212	The RET instruction was before the FEND instruction in the main program.	correct the problem.	
4213	More than 16 nesting levels are programmed.	Keep nesting levels at 16 or under.	
4220	Though an interrupt input occurred, the corresponding interrupt pointer does not exist.		
4221	An IRET instruction does not exist in the executed interrupt program.		
4223	An IRET instruction exists before the FEND instruction of the main program.	Read the common information of the	
4230	The number of CHK and CHKEND instructions is not equal.	error using the peripheral device, check error step corresponding to its numerical	0
4231	The number of IX and IXEND instructions is not equal.	value (program error location), and correct the problem.	
4235	The configuration of the check conditions for the CHK instruction is incorrect. Alternatively, a CHK instruction has been used in a low speed execution type program.		
4300	The designation of a MELSECNET/MINI-S3 master module control instruction was wrong.	Read the common information of the error using the peripheral device, check error step corresponding to its numerical	QnA
4301	The designation of an AD57/AD58 control instruction was wrong.	value (program error location), and correct the problem.	<u> </u>

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Γ Ο ¹		Common	Individual		/ Status	Operating	Diamantia
Error Code (SD0) *1	Error Messages	Information (SD5 to 15)	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Diagnostic Timing
4400	SFCP. CODE ERROR	Program error location		Off	Flicker	Stop	STOP → RUN
4410	CAN'T	Program error		Off	Flicker	Stop	STOP →
4411	SET (BL)	location		Oii	I IICK C I	Зюр	RUN
4420							
4421	CANUT	Dunganous course					STOD
4422	CAN'T SET (S)	Program error location		Off	Flicker	Stop	STOP → RUN
4500							
4501	SFCP.						
4502	FORMAT ERR.	Program error location		Off	Flicker	Stop	STOP → RUN
4503		:KK.					
4504							
4600							
4601	SFCP. OPE.	Program error location		Off/On	Flicker/ On	Continue	When instruction is
4602	ERROR	iocation			Oii	*2	executed

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*2} The CPU operation status when an error occurs can be set at the parameters. (LED display will change accordingly.)

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
4400	No SFCP or SFCPEND instruction in SFC program.	Read common information of the error	
4410	The block number designated by the SFC program exceeds the range.	using the peripheral device, check error step corresponding to its numerical	
4411	Block number designations overlap in SFC program.	value (program error location), and correct the problem.	
4420	A step number designated in an SFC program exceeds 511.		
4421	Total number of steps in all SFC programs exceed the range	Reduce total number of steps to below the maximum.	
4422	Step number designations overlap in SFC program.	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	
4500	The numbers of BLOCK and BEND instructions in an SFC program are not equal.		
4501	The configuration of the STEP * to TRAN * to TSET to SEND instructions in the SFC program is incorrect.	Read common information of the error	
4502	There was no STEPI * instruction in SFC program block.	using the peripheral device, check error step corresponding to its numerical value (program error location), and	0
4503	The step designated by the TSET instruction in the SFC program does not exist.	correct the problem.	
4504	The step designated by the TAND instruction in the SFC program does not exist.		
4600	The SFC program contains data that cannot be processed.	Read common information of the error	
4601	Exceeds device range that can be designated by the SFC program.	using the peripheral device, check error step corresponding to its numerical	0
4602	The START instruction in an SFC program is proceeded by an END instruction.	value (program error location), and correct the problem.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	F.,	Common	Individual		<u>/</u> Status	Operating	Di
Error Code (SD0) *1	Error Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	DLIN	ERROR	Statuses of CPU	Diagnostic Timing
4610	SFCP.	Program error					
4611	EXE. ERROR	location		On	On	Continue	STOP →RUN
4620	BLOCK	Program error					When
4621	EXE. ERROR	location		Off	Flicker	Stop	instruction is executed
4630							
4631	STEP EXE. ERROR	Program error location		Off	Flicker	Stop	When instruction is executed
4632							
4633							
5000	WDT ERROR	Time (value set)	Time (value actually	Off	Flicker	Stop	Always
5001	LIKKOK		measured)				

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code (SD0) *	Error Contents and Cause	Corrective Action	Corres- ponding CPU
4610	The active step information at presumptive start of an SFC program is incorrect.	Read common information of the error using the peripheral device, check error step corresponding to its numerical	
4611	Key-switch was reset during RUN when presumptive start was designated for SFC program.	The program is automatically subjected to an initial start.	
4620	Startup was executed at a block in the SFC program that was already started up.	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	0
4621	Startup was attempted at a block that does not exist in the SFC program.	Reset the CPU module and RUN it again. If the same error is displayed again, the intelligent function module, CPU module or base unit is faulty. Contact your nearest Mitsubishi representative.	
4630	Startup was executed at a block in the SFC program that was already started up.	Read common information of the error using the peripheral device, check error step corresponding to its numerical value (program error location), and correct the problem.	
4631	Startup was attempted at a block that does not exist in an SFC program.	Reset the CPU module and RUN it again. If the same error is displayed again, the intelligent function module, CPU module or base unit is faulty. Contact your nearest Mitsubishi representative.	0
4632	There were too many simultaneous active steps in blocks that can be designated by the SFC program.	Read common information of the error using the peripheral device, check error step corresponding to its numerical	
4633	There were too many simultaneous active steps in all blocks that can be designated.	value (program error location), and correct the problem.	
5000	Program scan time for initial execution type programs exceeds the initial execution WDT time setting designated in the PLC RAS parameter.	Read the individual information of the error using the peripheral device, check the numerical value (time) there, and	0
5001	The program scan time goes over the WDT value set in the parameter PLC RAS parameter.	shorten scan time if necessary.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

	1	1	Joue List (Col				T T
Error Code (SD0) *1	Error Messages	Common Information (SD5 to 15) * 1	Individual Information (SD16 to 26) *1	RUN	Status ERROR	Operating Statuses of CPU	Diagnostic Timing
5010	PRG. TIME OVER		Time (value	On	On	Continue	Always
6000	PRG. VERIFY ERR. * 5	File name		Off	Flicker	Stop	Always
6010	MODE VERIFY ERR. * 5			On	On	Continue	Always
6100	TRK. MEMORY ERR. *3			On	On	Continue	At power on/ Reset/STOP →RUN
6101							When END instruction executed
6200	CONTROL EXE. *4	Cause of switch		On	Off	Continue	Always
6210	CONTROL WAIT. * 5	Cause of switch		On	Off	Continue	Always
6220	CAN'T EXE CHANGE *4	Cause of switch		On	On	Continue	At switching request
6221							

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*3} Can only be detected in a redundant system. Can be detected either in the control system or the standby system.

^{*4} Can only be detected in the control system of a redundant system.

^{*5} Can only be detected in the standby system of a redundant system.

Err Co (SD0	de	Error Contents and Cause	Corrective Action	Corres- ponding CPU
50	10	 The scan time of the program exceeded the constant scan setting time specified in the PLC RAS setting parameter. The low speed program execution time specified in the PC RAS setting parameter exceeded the margin time of constant scan. 	 Review the constant scan setting time. Review the constant scan time and low speed program execution time in the parameter so that the margin time of constant scan may be fully reserved. 	0
50	11	Low speed execution type program scan time goes over the low speed execution WDT set in the parameter PLC RAS settings.	Read the individual information of the error using the peripheral device, check the numerical value (time) there, and shorten scan time if necessary.	
600	00	The control system and standby system in the redundant system do not have the same programs and parameters.	Synchronise the programs and parameters of the control system and standby system.	Q4AR
60	10	The operational status of the control system and standby system in the redundant system is not the same.	Synchronise the operation statuses of the control system and standby system.	Q+7 II C
610	00	A CPU module tracking memory error was detected during initial.	Because this is a CPU module hardware error, contact your nearest Mitsubishi representative. To replace the module, replace the standby system CPU first, then the control system CPU.	Q4AR
610	01	The CPU module detected an error during the handshake for tracking.	Check the condition of the other stations.	
620	00	The standby system in a redundant system is switched to the control system.	Check the control system condition.	
62	10	The control system in a redundant system is switched to the standby system.	Check the control system condition.	
622	20	 Because the standby system is in an error or the like with a redundant system, the control system does not switch to the standby system. Failure to switch to the standby system due to a network error or the like of the control system 	Check the standby system condition.	Q4AR
622		Switching is disabled because of a bus switching module error.	Because this is a bus switching module hardware error, contact your nearest Mitsubishi representative.	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

- • •	_	Common	Individual		Status	Operating	D: ::	
Error Code (SD0) *1	Error Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	DLIN	ERROR	Statuses of CPU	Diagnostic Timing	
	DUAL SYS ERROR			On	On	Continue	Always	
7000							Always	
							At power ON/Reset	
	MULT CPU DOWN	Unit No.		Off	Flicker	Stop	At power ON/Reset	
7003								

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*4} Can only be detected in the control system of a redundant system.

(\$	Error Code SD0) *1	Error Contents and Cause	Corrective Action	Corres- ponding CPU
		The link module mounted on the standby type CPU is the remote master station.	Check the system configuration status.	Q4AR
		 In a multiple CPU system, at CPU module fault occurred at a station where "All station stop by stop error of PLC " was selected in the operating mode. High Performance model QCPU of function version A was loaded in a multiple CPU system. In a multiple CPU system, station 1 resulted in stop error at power-on and the other stations cannot start. (This error occurred at stations 2 to 4) 	 (1) Read the individual information of the error using the peripheral device, check the error of the PLC resulting in CPU module fault, and remove the error. (2) Remove the High Performance model QCPU of function version A from the main base unit. Read the individual information of the error using the peripheral device, check the error of the CPU module resulting in CPU module fault, and remove the error. (1) Reset the High Performance model QCPU and run it again. If the same error is displayed again, it is a 	QCPU function
	7002	 There is no response from the target CPU module in a multiple CPU system at initial communication stage. High Performance model QCPU of function version A was loaded in a multiple CPU system configuration. 	error is displayed again, it is a hardware fault of any CPU module. Consult your sales representative. (2) Remove the High Performance model QCPU of function version A from the main base unit. Alternatively, replace the High Performance model QCPU of function version A with the High Performance model QCPU of function version B.	Ver. B or later
		There is no response from the target CPU module in a multiple CPU system at initial communication stage.	Reset the High Performance model QCPU and run it again. If the same error is displayed again, it is a hardware fault of any CPU module. Consult your sales representative.	

 $[\]ast\,1$ Characters in parentheses () indicate the special register numbers where individual information is being stored.

Error Code	Error	Common			Operating	Diagnostic		
(SD0) *1	Messages	Information (SD5 to 15) * 1	Information (SD16 to 26) *1	RUN	ERROR	Statuses of CPU	Diagnostic Timing	
7010	MULTI EXE. ERROR	Unit No.		Off	Flicker	Stop	At power ON/Reset	
7020	MULTI CPU ERROR	Unit/module No.		On	On	Continue	Always	
9000	F**** *6	Program error location	Annunciator number	On USER	Off LED On	Continue	When instruction is executed	
9010	<chk> ERR ***-***</chk>	Program error location	Failure No.	On USER	Off LED On	Continue	When instruction is executed	
9020	воот ок			Off	Flicker	Stop	At power ON/Reset	
10000	CONT. UNIT ERROR			Off	Flicker	Continue	Always	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

^{*6 * * * *} indicates detected annunciator number.

^{*7 ***} indicates detected contact and coil number.

Error Code (SD0) *1	Error Contents and Cause	Corrective Action	Corresponding CPU	
7010	 Faulty CPU is loaded in a multiple CPU system. High Performance model QCPU of function version A is loaded in a multiple CPU system configuration. (An error is detected at the High Performance model QCPU of function version B.) In a multiple CPU system, any of CPU No. 2 to 4 was reset during power-on. (This error occurs at only the CPU module which was reset.) 	 (1) Read the individual information of the error using the peripheral device, and change the faulty station. (2) Change the station of function version A for function version B. (3) Do not reset the CPU modules of CPU No.2 to 4. Reset the High Performance model QCPU of CPU No.1 and restart the multiple CPU system. 	QCPU function Ver. B or later	
7020	In a multiple PLC system, a PLC fault occurred at a CPU module where "All station stop by stop error of PLC" was not selected in the operation mode. (The error is detected at the CPU module of other than the station where the CPU fault occurred.)	Read the individual information of the error using the peripheral device, check the error of the CPU module resulting in CPU module fault, and remove the error.		
9000	Annunciator (F) was set ON	Read the individual information of the error using the peripheral device, and check the program corresponding to the numerical value (annunciator number).	(
9010	Error detected by the CHK instruction.	Read the individual information of the error using the peripheral device, and check the program corresponding to the numerical value (error number) there.	0	
9020	Storage of data onto ROM was completed normally in automatic write to standard ROM. (BOOT LED also flickers.)	Set the parameter enable drive to standard ROM, switch power on again, and perform boot operation from standard ROM.	QCPU function Ver. B or later	
10000	In the multiple CPU system, an error occurred in the CPU module other than the Process CPU/High Performance model QCPU.	Use the software package of the corresponding CPU module to check the details of the error that occurred.	QCPU function Ver. B or later	

^{*1} Characters in parentheses () indicate the special register numbers where individual information is being stored.

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- This product has been manufactured under strict quality control. However, when
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